

Compal Confidential

Tampa Bay NPVAA

LA-5841P Schematics Document

Intel PineView Processor/ Tiger point

2009-10-21

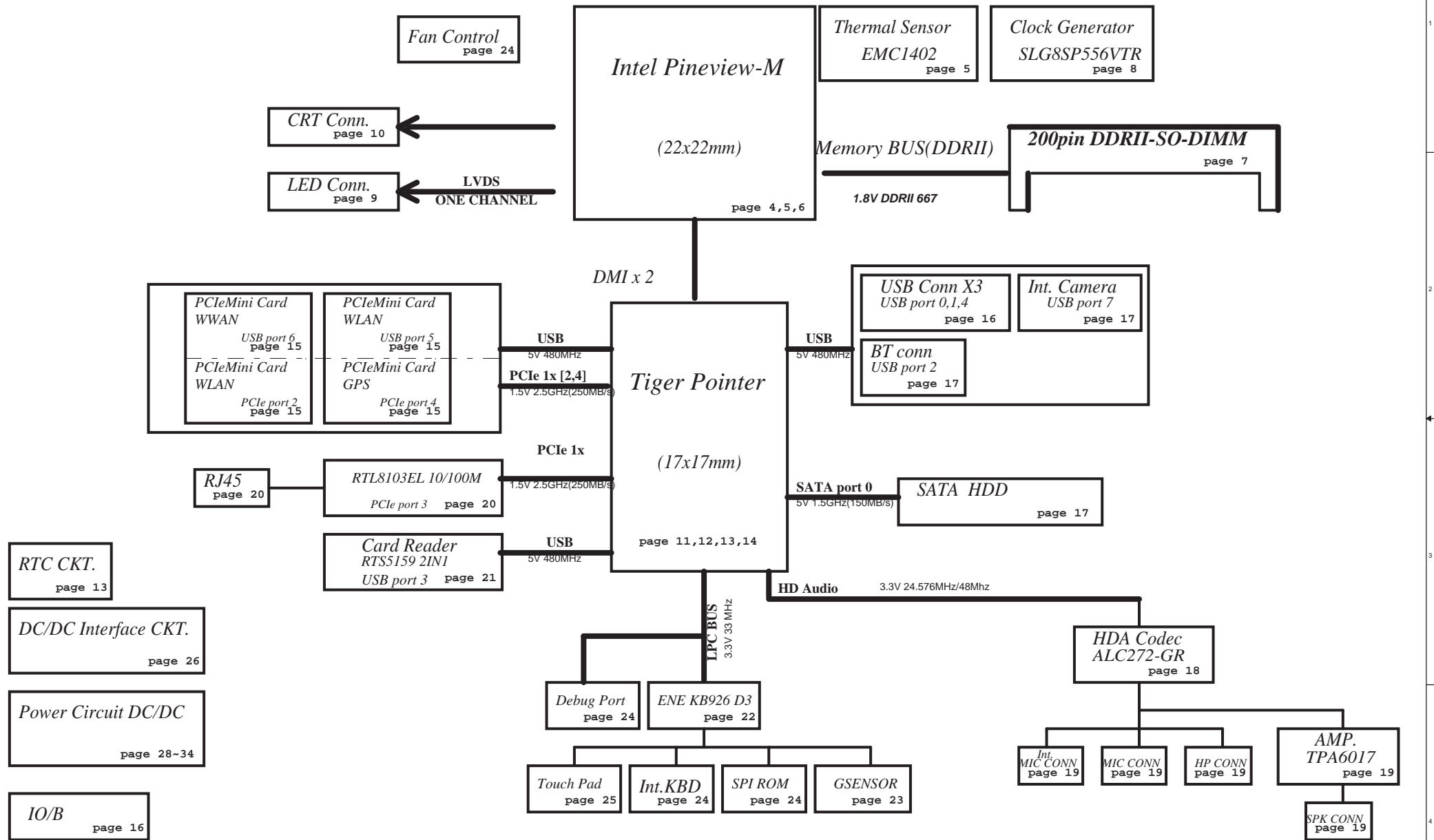
REV: 1.0

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Model Name : NPVAA

File Name : LA-5841P



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Voltage Rails

Power Plane	Description	S1	S3	S5	G3
VIN	Adapter power supply (19V)	ON	ON	ON	OFF
B+	AC or battery power rail for power circuit.	ON	ON	ON	ON
+CPU_CORE	Core voltage for CPU	ON	OFF	OFF	OFF
+0.89VS	0.89VS GFX support voltage	ON	OFF	OFF	OFF
+0.9VS	0.9V switched power rail for DDR terminator	ON	OFF	OFF	OFF
+1.05VS	VCCP switched power rail	ON	OFF	OFF	OFF
+1.5VS	1.5V switched power rail	ON	OFF	OFF	OFF
+1.8V	1.8V power rail for DDR	ON	ON	OFF	OFF
+1.8VS	1.8VS switched power rail	ON	OFF	OFF	OFF
+3VALW	3.3V always on power rail	ON	ON	ON	OFF
+3V_SB	3.3V power rail for LAN	ON	ON	OFF	OFF
+3V_LAN	3.3V power rail for LAN	ON	ON	OFF	OFF
+3V_WLAN	3.3V power rail for LAN	ON	ON	OFF	OFF
+3VS	3.3V switched power rail	ON	OFF	OFF	OFF
+5VALW	5V always on power rail	ON	ON	ON	OFF
+5V_SB	5V power rail for SB	ON	ON	OFF	OFF
+5VS	5V switched power rail	ON	OFF	OFF	OFF
+VSB	VSB always on power rail	ON	ON	ON	OFF
+RTCVCC	RTC power	ON	ON	ON	ON

Note : ON* means that this power plane is ON only with AC power available, otherwise it is OFF.

STATE \ SIGNAL	SLP_S3#	SLP_S4#	SLP_S5#	+VALW	+V	+VS	Clock
Full ON	HIGH	HIGH	HIGH	ON	ON	ON	ON
S1(Power On Suspend)	HIGH	HIGH	HIGH	ON	ON	ON	LOW
S3 (Suspend to RAM)	LOW	HIGH	HIGH	ON	ON	OFF	OFF
S4 (Suspend to Disk)	LOW	LOW	HIGH	ON	OFF	OFF	OFF
S5 (Soft OFF)	LOW	LOW	LOW	ON	OFF	OFF	OFF

BTO Option Table

Function	Mini PCI-E SLOT				STAR			
description								
explain	Wi-Fi	WiMax	3GGPS	3G	POWER SAVING			
BTO	WLAN@	WIMAX@	3GGPS@	3G@	STAR@			

Function			
description			
explain			
BTO			

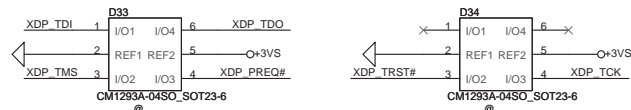
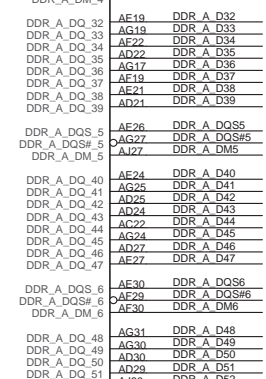
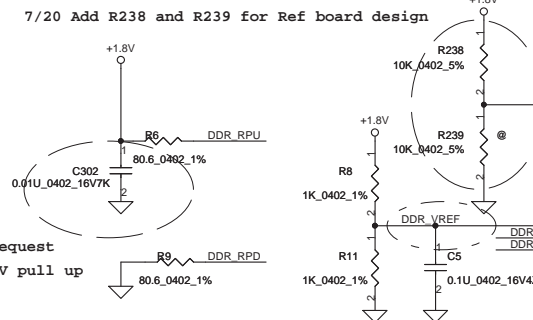
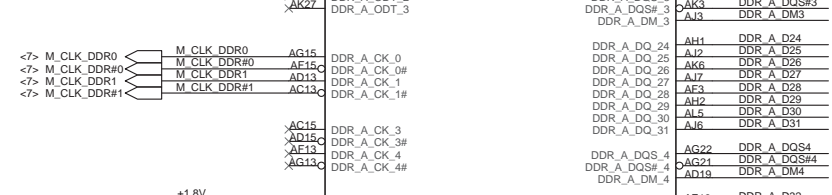
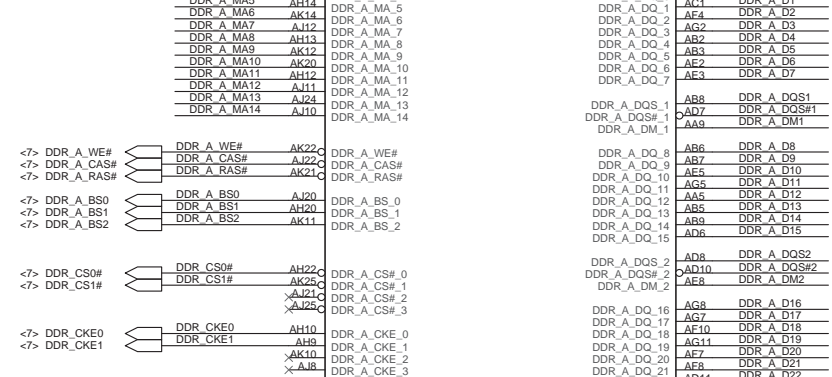
EC SM Bus1 address

EC SM Bus2 address

Device	Address	Device	Address
Smart Battery	0001 011X b	EMC1402	1001 010X b

Tiger point SM Bus address

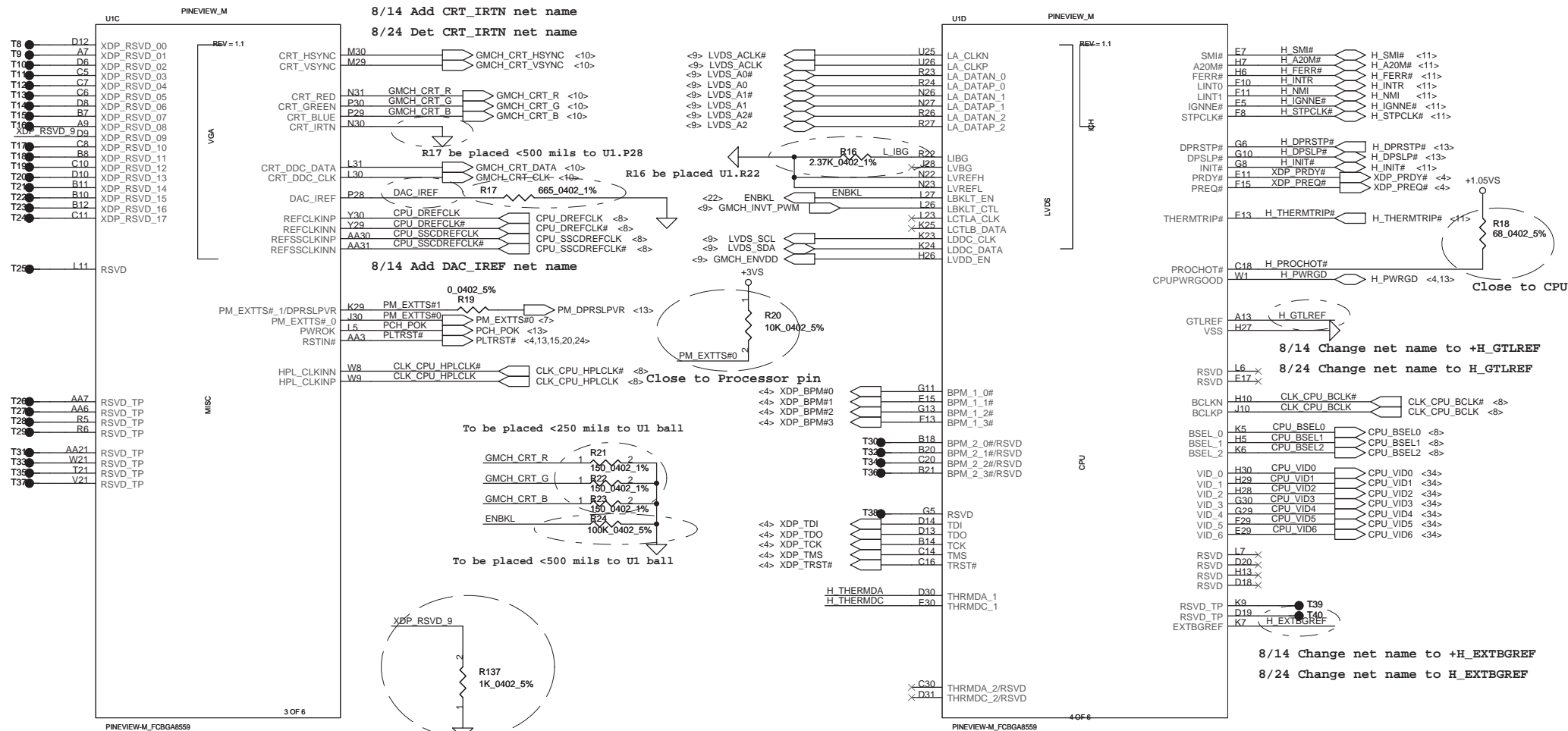
Device	Address
Clock Generator (SLG8SP556VTR)	1101 001Xb
DDR DIMMA	1010 000Xb



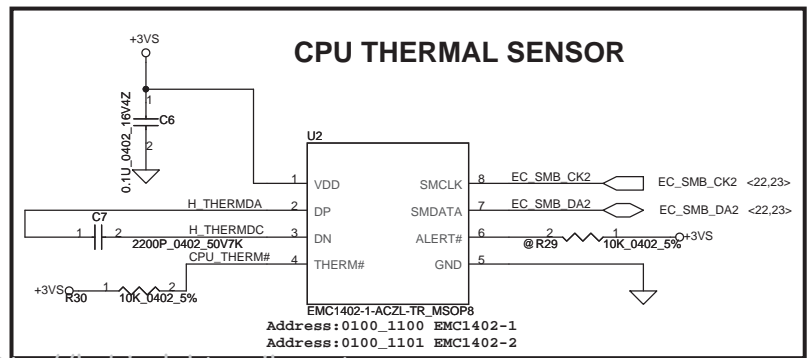
DDR_A

PINEVIEW-M FCBA8559

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7/21 Pull down 1K to GND for Intel request

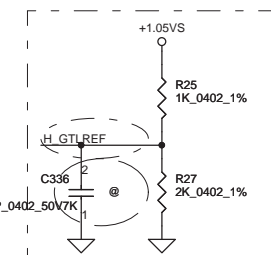


H_DPRSTP#	C151	1	@ 220P_0402_50V7K
H_DPSLP#	C152	1	@ 220P_0402_50V7K
H_PWRGD	C154	1	@ 220P_0402_50V7K
H_A20M#	C134	1	@ 220P_0402_50V7K
H_IGNNE#	C135	1	@ 220P_0402_50V7K
H_INIT#	C136	1	@ 220P_0402_50V7K
H_INTR	C137	1	@ 220P_0402_50V7K
H_FERR#	C138	1	@ 220P_0402_50V7K
H_NMI	C139	1	@ 220P_0402_50V7K
H_SMI#	C140	1	@ 220P_0402_50V7K
H_STPCLK#	C141	1	@ 220P_0402_50V7K

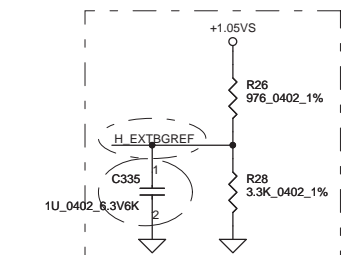
7/20 Reserve C336 for Ref board design

ESD request

placed within 0.5" of processor pin.

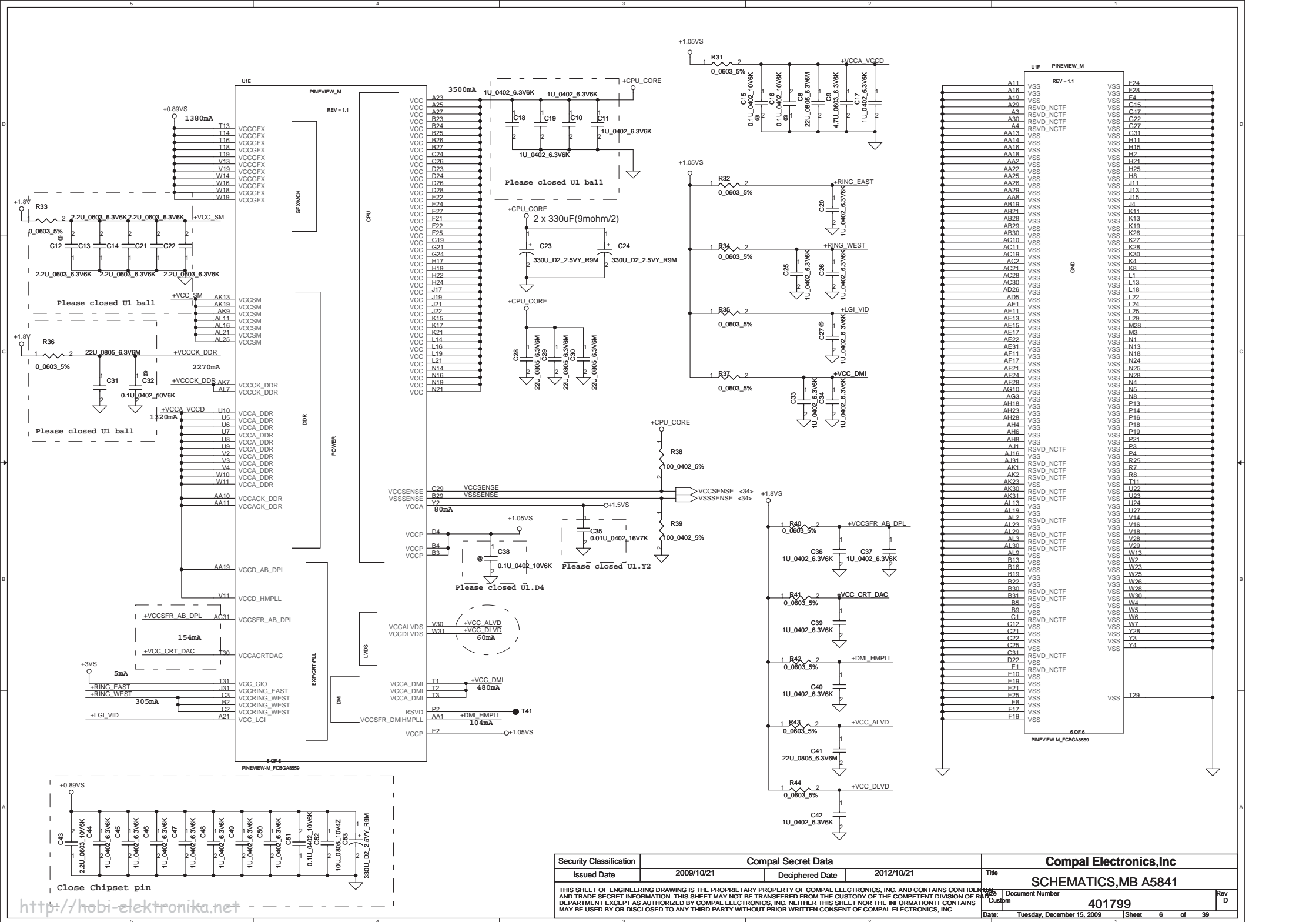


placed within 0.5" of processor pin and 5 mils spacing



7/20 Add C335 for Ref board design

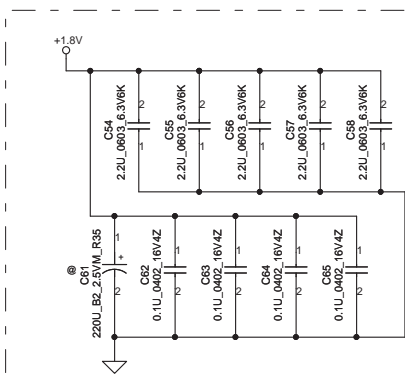
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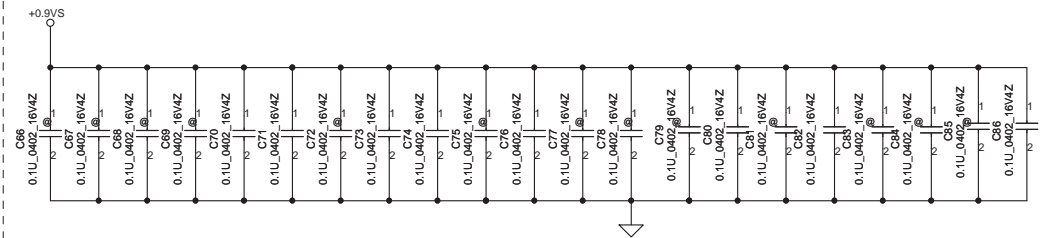
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<4> DDR_A_DQS#[0..7]
 <4> DDR_A_D[0..63]
 <4> DDR_A_DM[0..7]
 <4> DDR_A_DQS#[0..7]
 <4> DDR_A_MA[0..14]

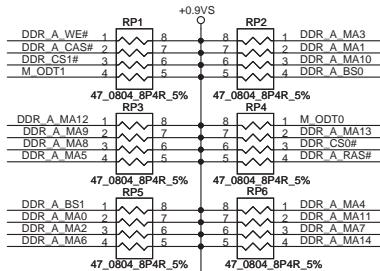
Layout Note:
Place near JDDR1



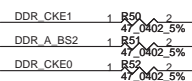
Layout Note:
Place one cap close to every 2 pullup resistors terminated to +0.9VS



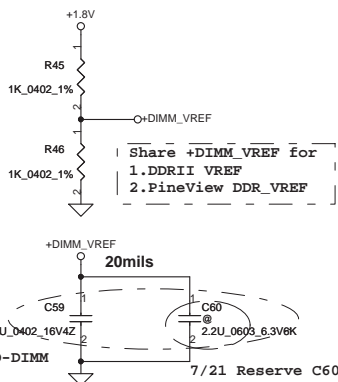
9/4 Reserve C66, C67, C68, C69, C72, C75, C77, C78, C79, C81, C83, C84, C85



Layout Note:
Place these resistor closely DIMMA, all trace length < 1000 mil

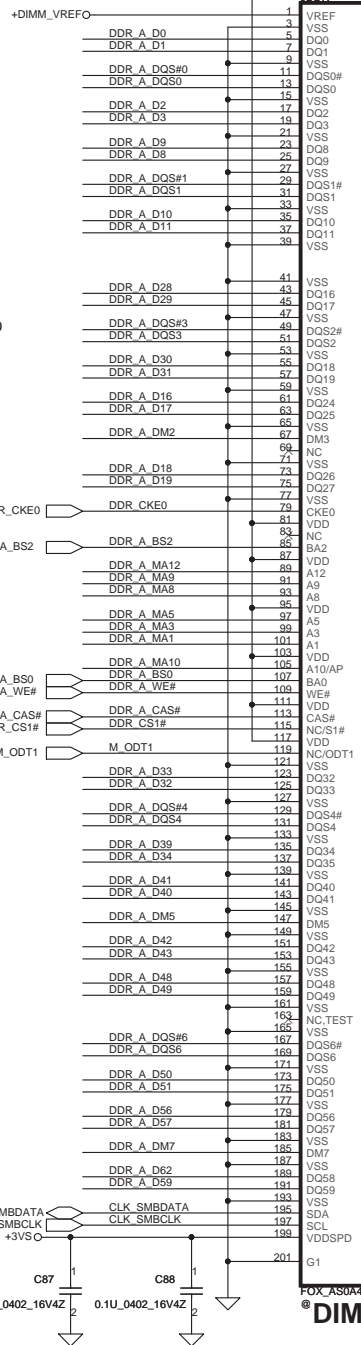


Layout Note:
Place these resistor closely DIMMA, all trace length Max=1000 mil



Please closed SO-DIMM

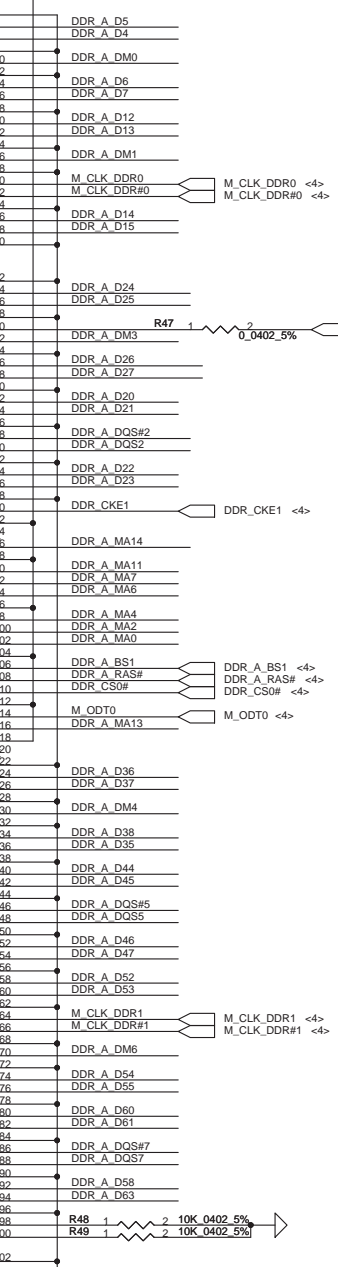
7/8 Add 4PCS CAP on 1.8V for EMI request



DIMMA

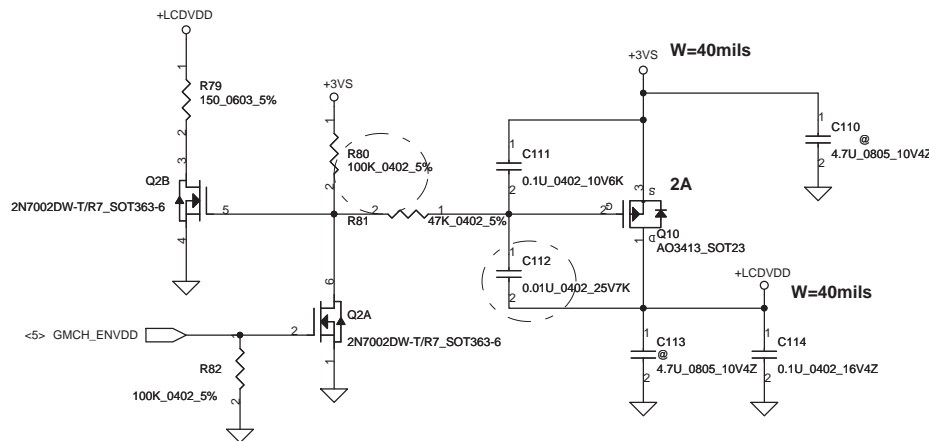
FOX ASS0426-NASN-7F_200P

@ DIMMA

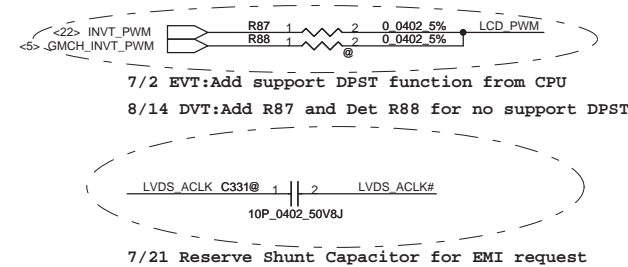
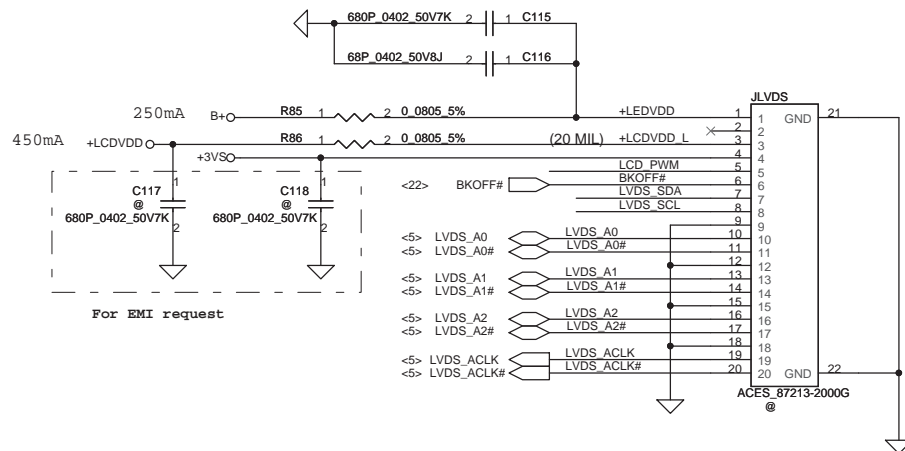
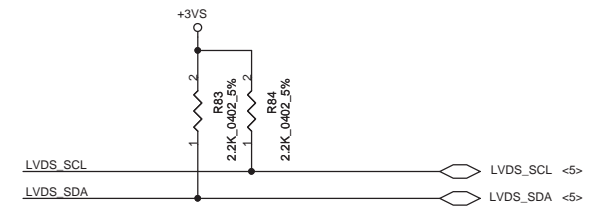


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LCD POWER CIRCUIT



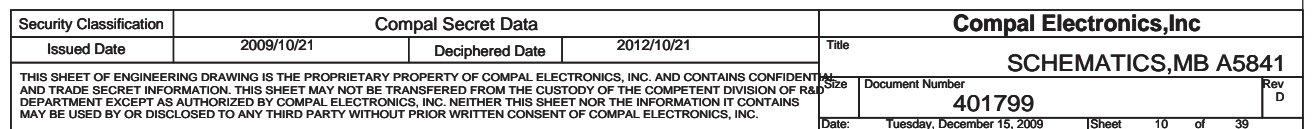
LED/PANEL BD. Conn.

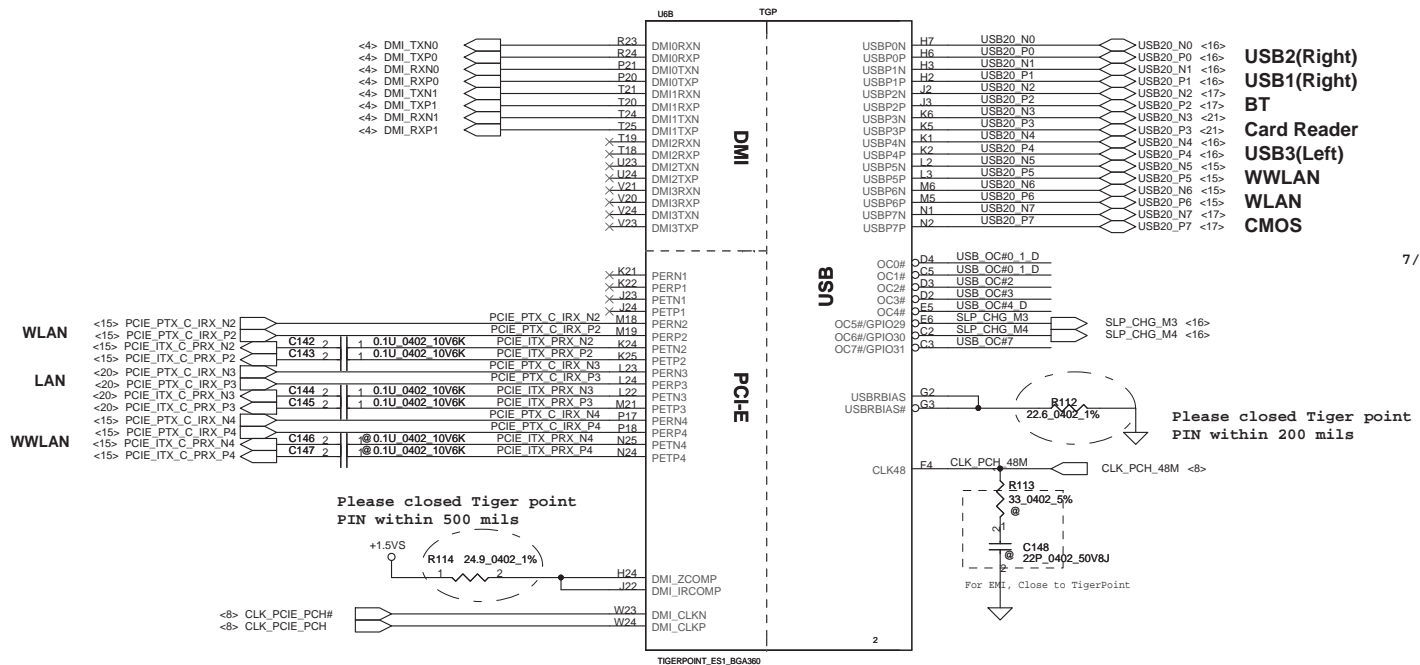


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7/10 Add J2 for cost down PolySwitch
9/28 Reserve F1 for cost down PolySwitch

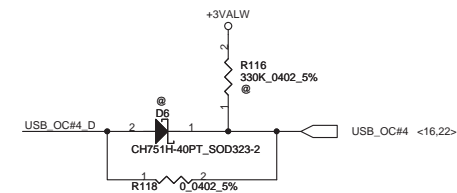
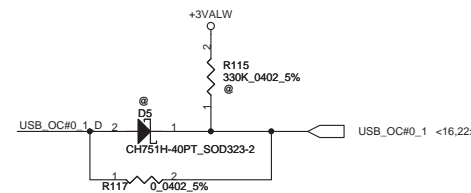
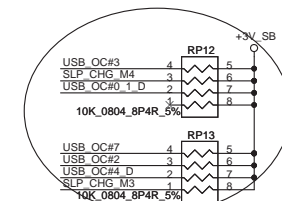




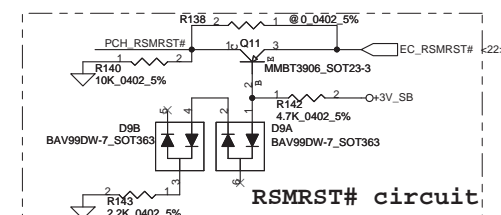
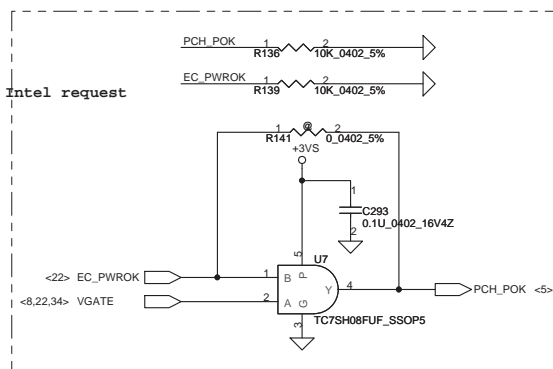
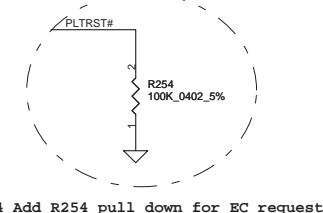
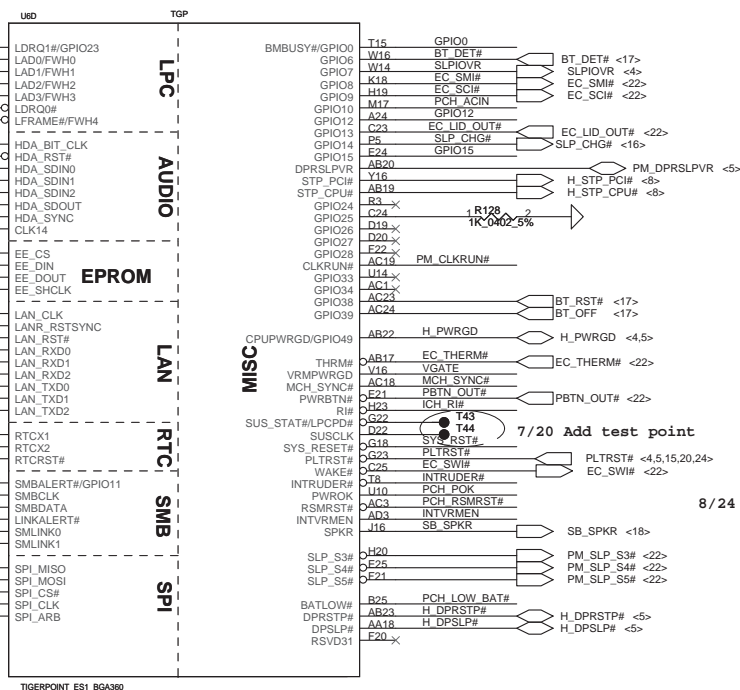
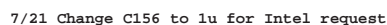
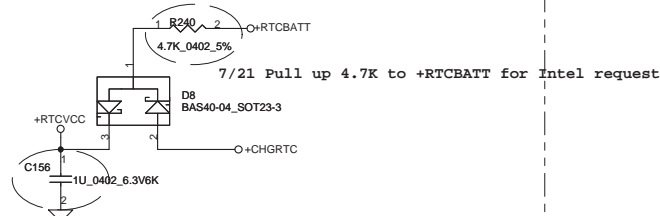
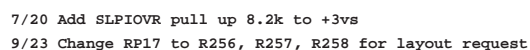
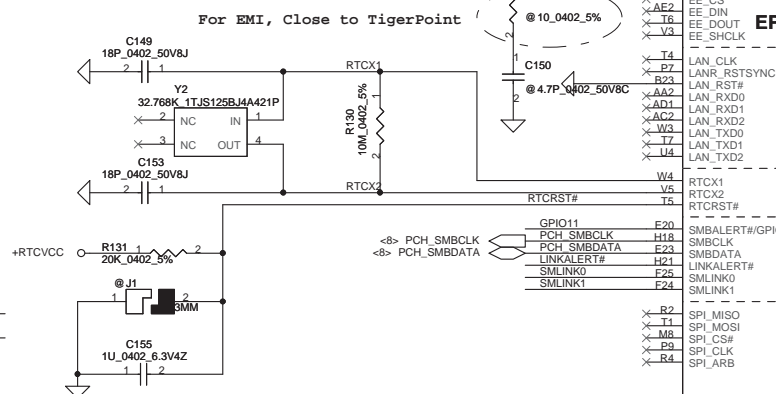
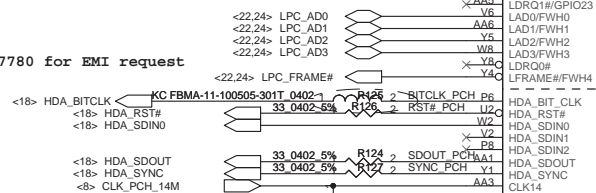
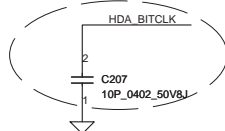
USB PORT LIST

PORT	DEVICE	Modify
USB0	USB3(Left)	USB2(Right)
USB1	BT	USB1(Right)
USB2	Card Reader	BT
USB3	USB2(Right)	Card Reader
USB4	USB1(Right)	USB3(Left)
USB5	WWLAN	WWLAN
USB6	WLAN	WLAN
USB7	CMOS	CMOS

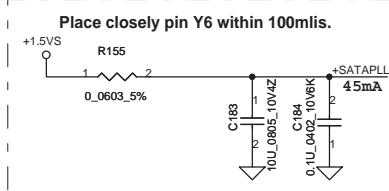
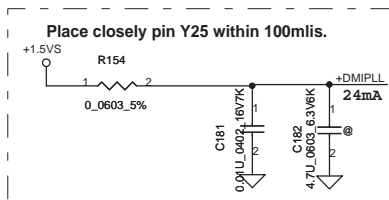
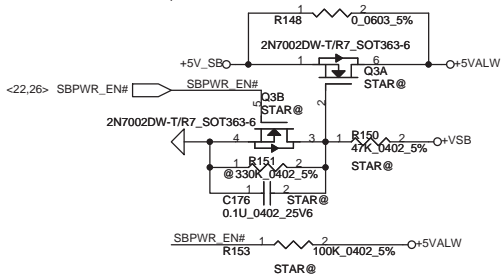
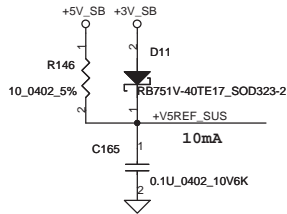
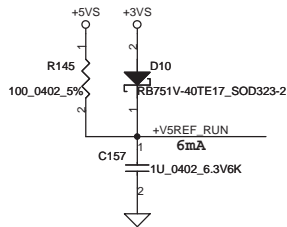
7/17 Reassign Tiger point USB port for TOSHIBA concern



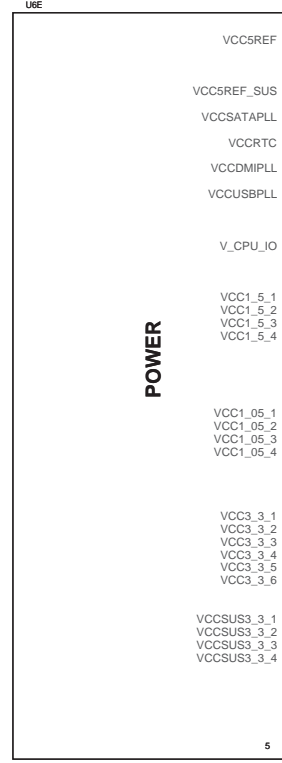
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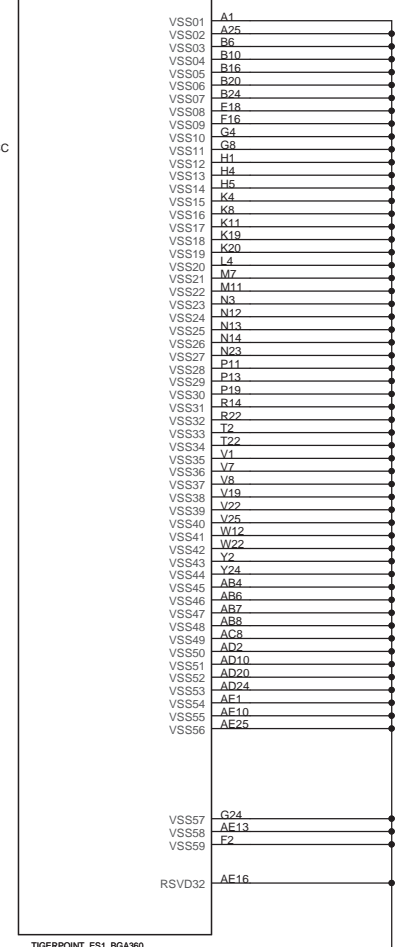


TGP



TIGERPOINT_ES1_BGA360

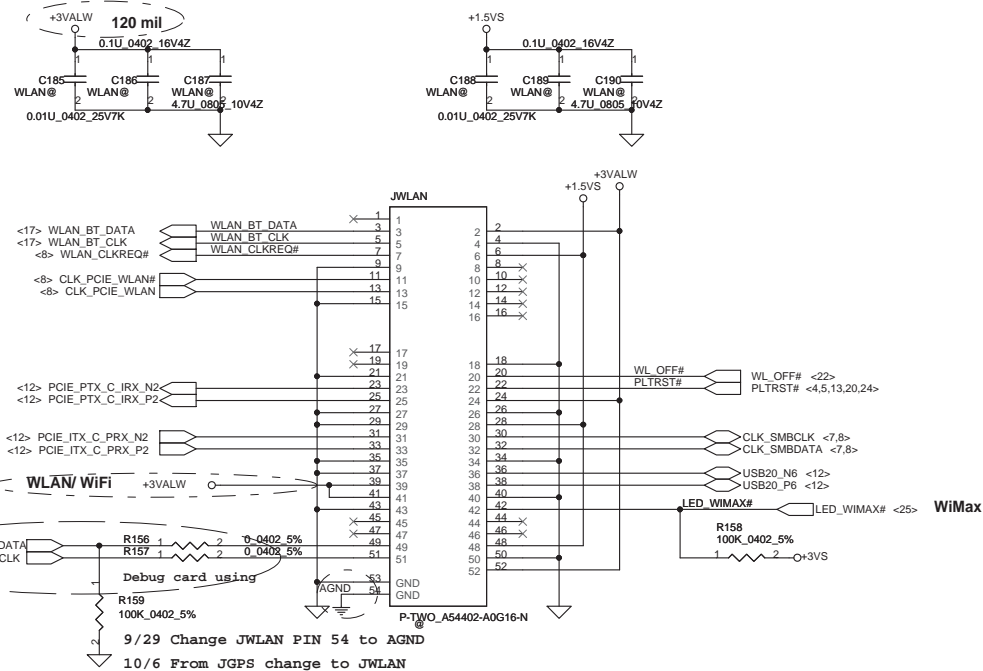
UBF TGP



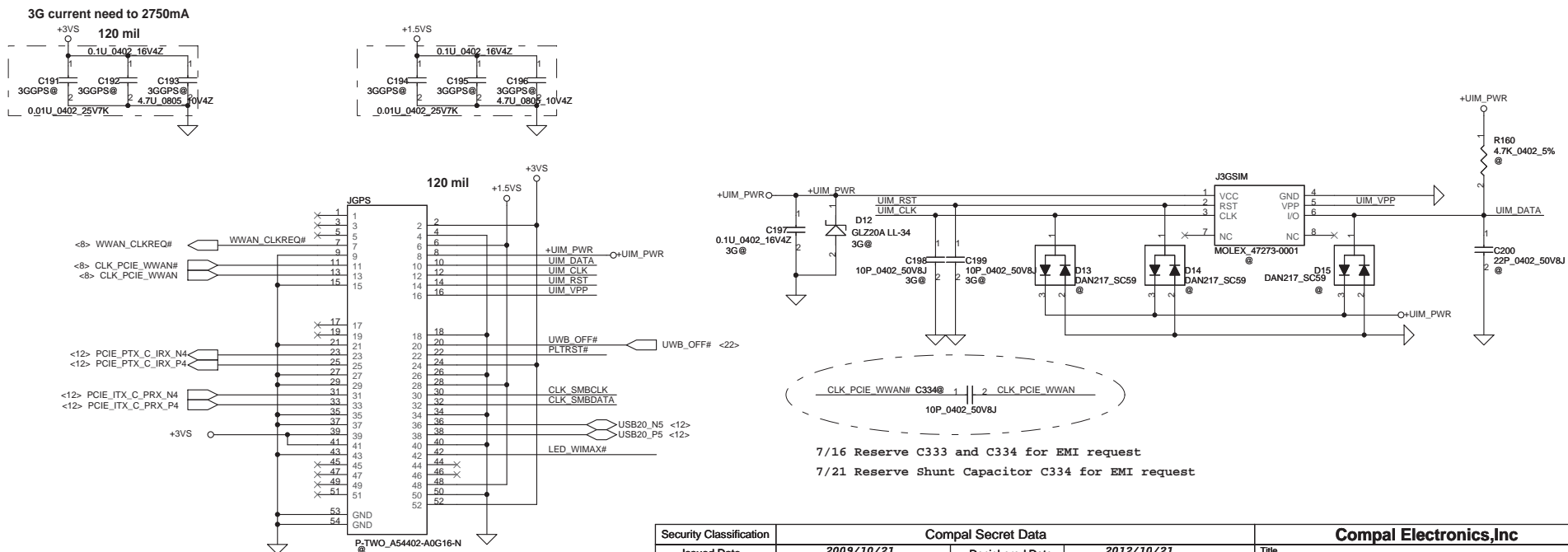
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Mini-Express Card for WLAN/WiMax



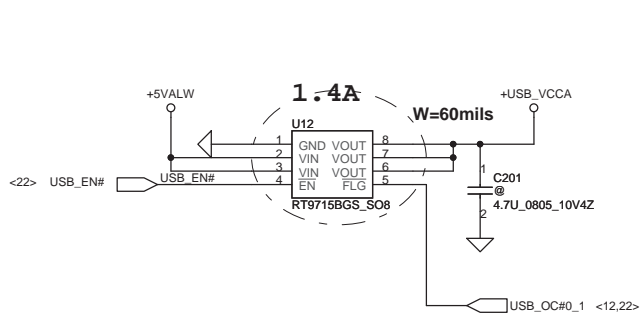
Mini-Express Card for 3G/GPS



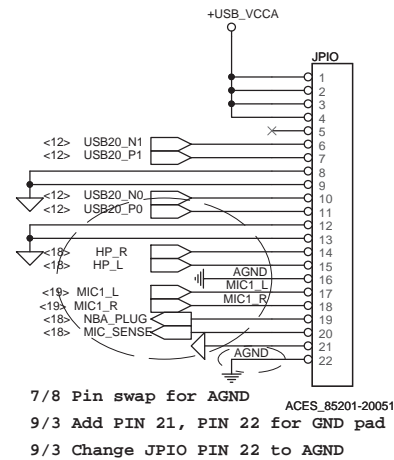
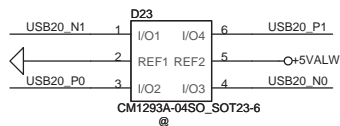
7/16 Reserve C333 and C334 for EMI request
7/21 Reserve Shunt Capacitor C334 for EMI request

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USB CONN--Right

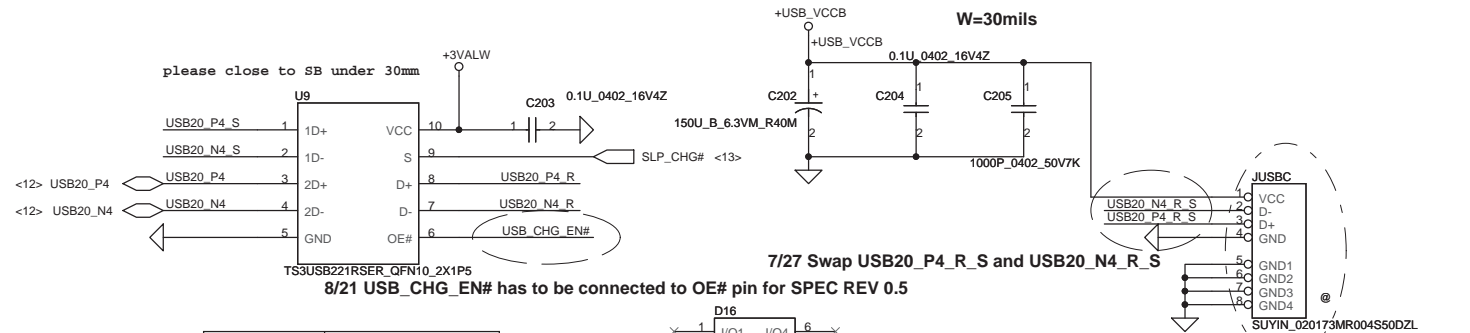
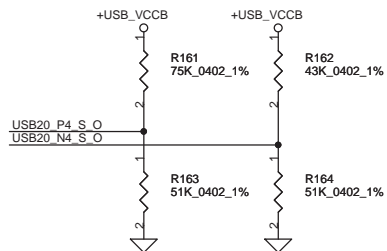


8/24 Change U12 to SA00002XX00 for discharge +USB_VCCA

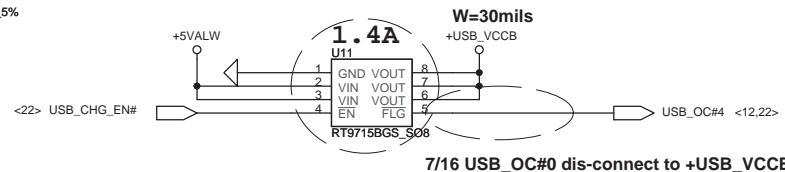
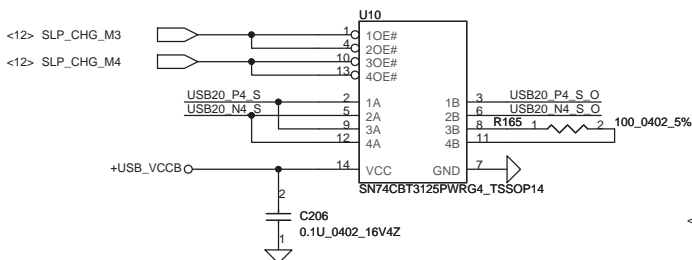


7/8 ESD diode change location from Sub board to M/B
9/28 D36 for ESD request

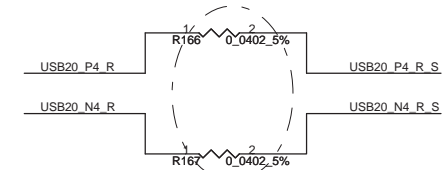
USB Board--Left



SLP_CHG	FUNCTION
LOW	D=1D
HIGH	D=2D



7/17 Change U11 to SA00002XX00 for discharge +USB_VCCB

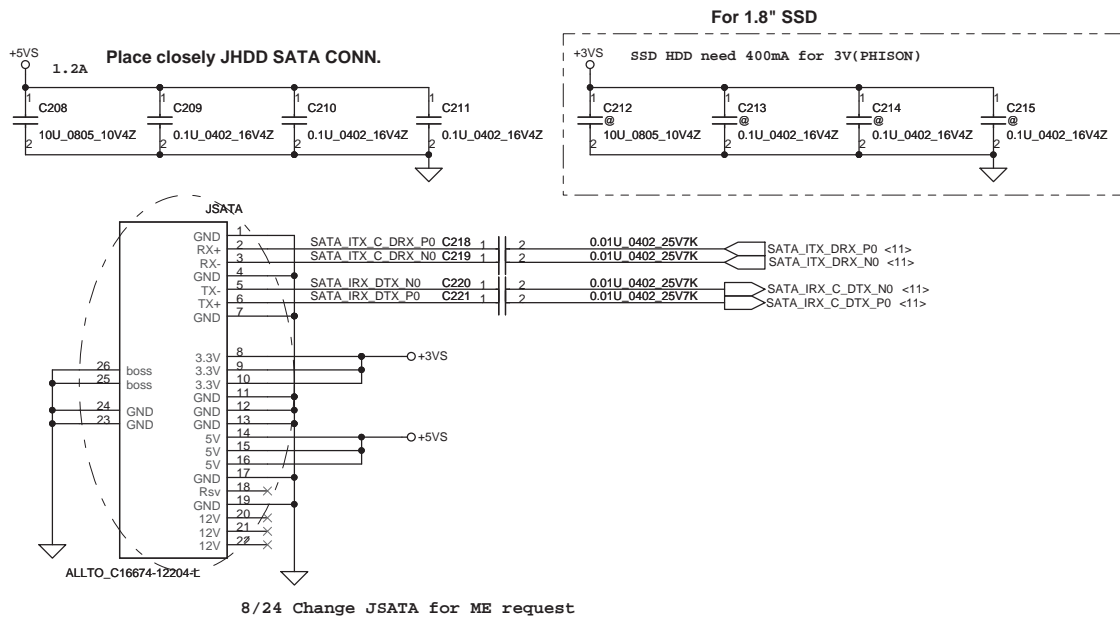


7/2 For EMI request and change to SM070001310
10/20 Delete L4 for EMI request

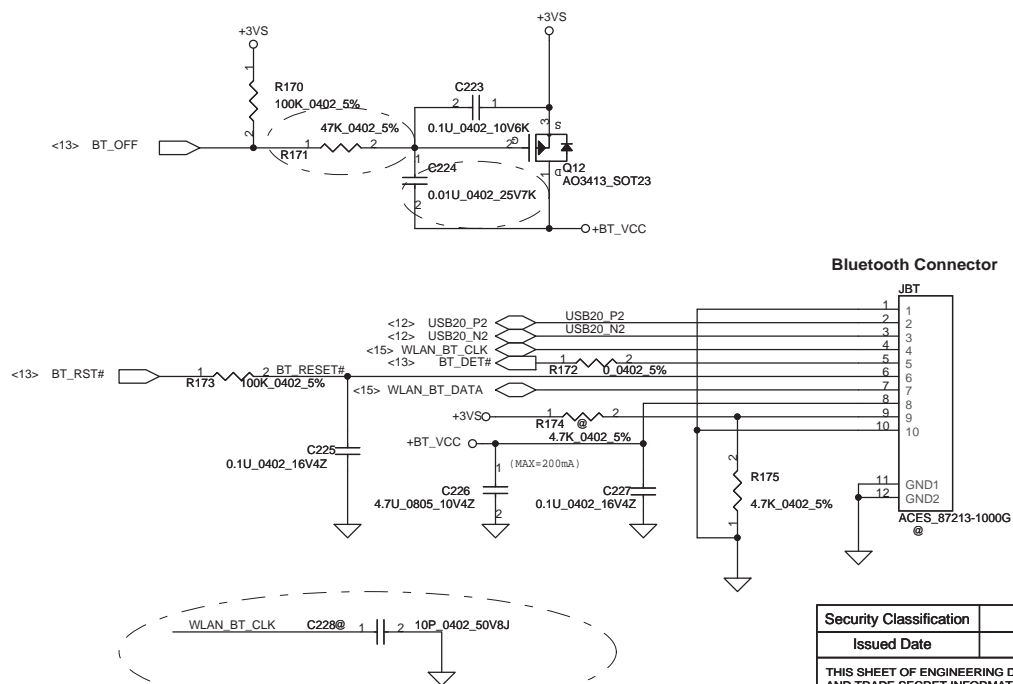
	SLP_CHG_M3	SLP_CHG_M4
Mode 3	HIGH	LOW
Mode 4	LOW	HIGH

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SATA Conn.

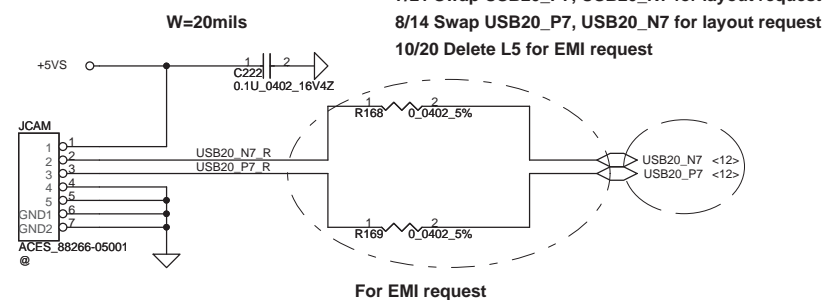


BlueTooth Interface



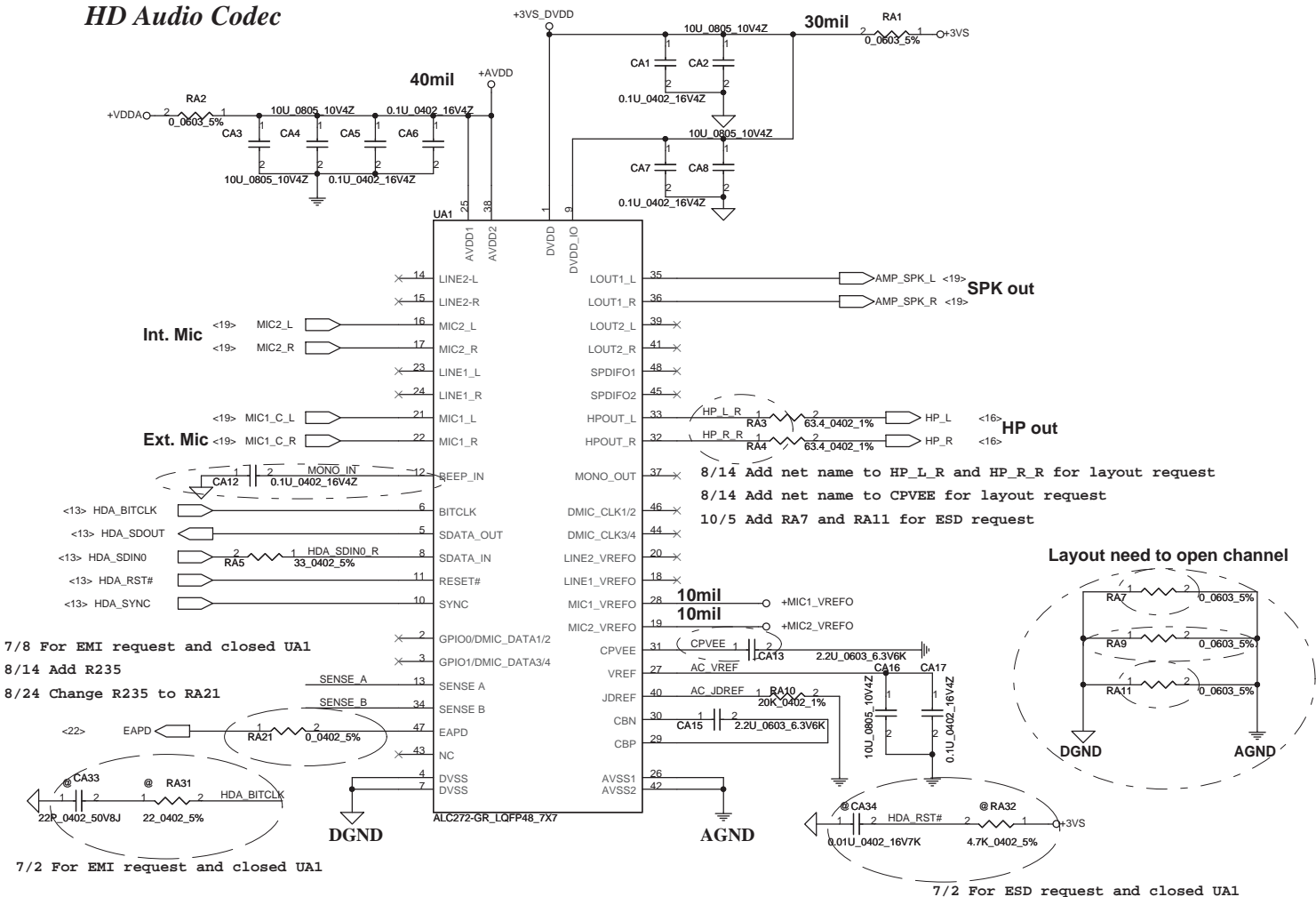
Camera Conn.

Int. Camera

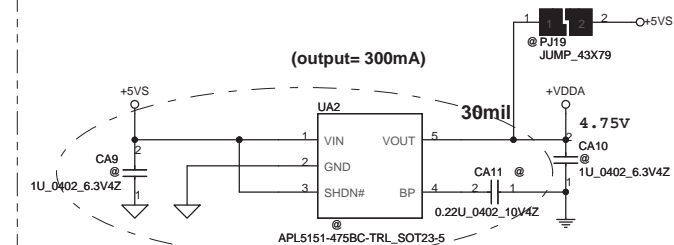


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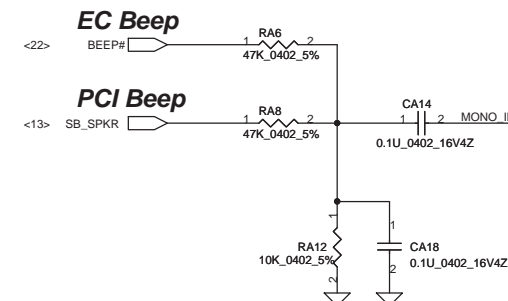
HD Audio Codec



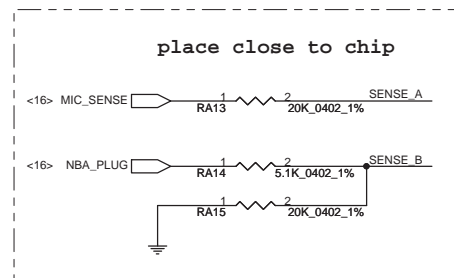
Audio regulator



Beep sound



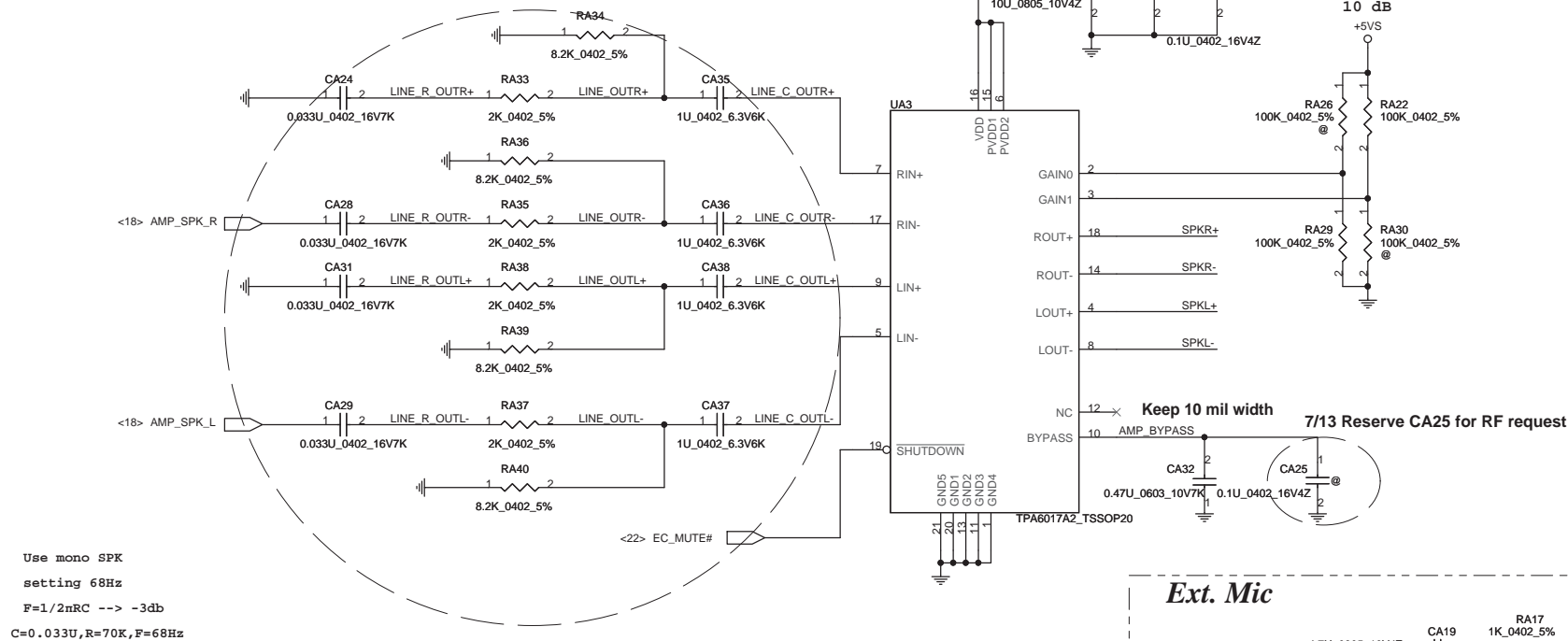
Sense Pin	Impedance	Codec Signals	Function
SENSE A	39.2K	PORT-A (PIN 39, 41)	Ext. MIC
	20K	PORT-B (PIN 21, 22)	
	10K	PORT-C (PIN 23, 24)	SPK out
	5.1K	PORT-D (PIN 35, 36)	
SENSE B	39.2K	PORT-E (PIN 14, 15)	Int. MIC
	20K	PORT-F (PIN 16, 17)	
	10K	PORT-H (PIN 37)	Headphone out
	5.1K	PORT-I (PIN 32, 33)	



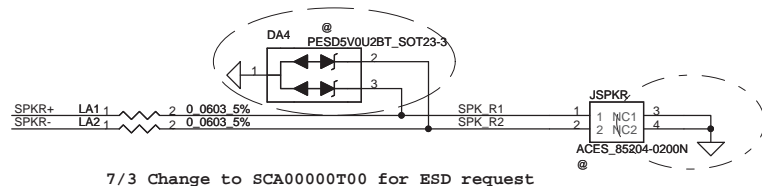
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TPA6017 Medium Range Amplifier

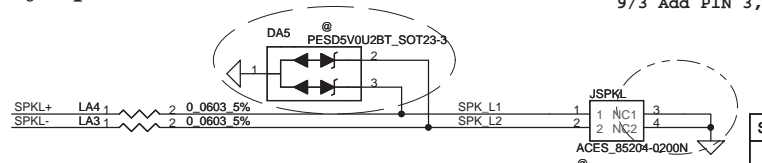
Rin = 70Kohm



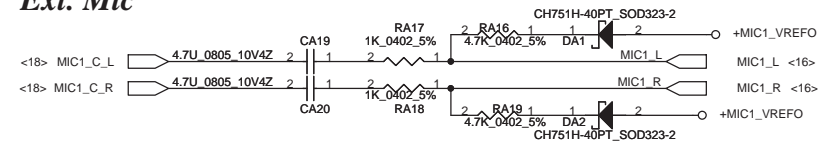
Right Speaker Connector



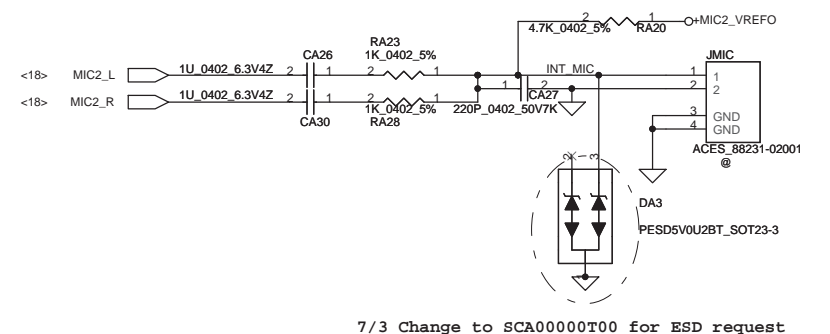
Left Speaker Connector



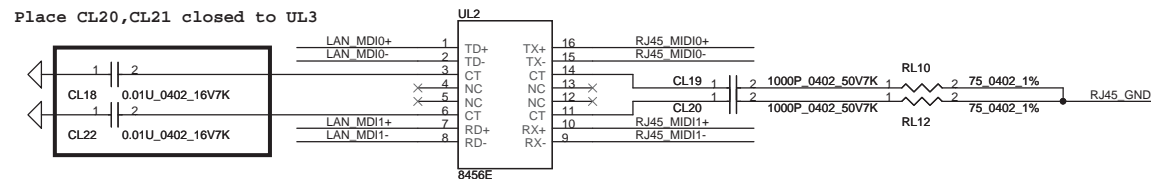
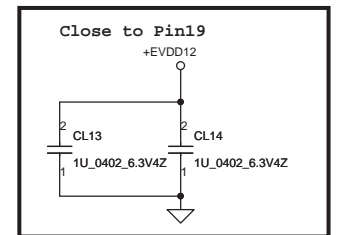
Ext. Mic



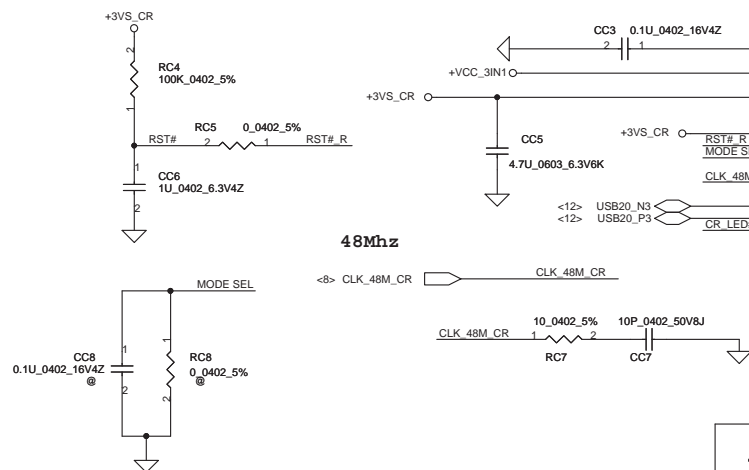
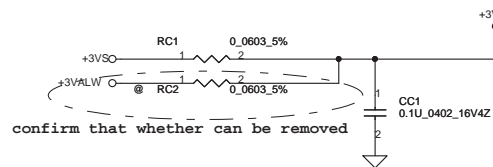
Int. Mic



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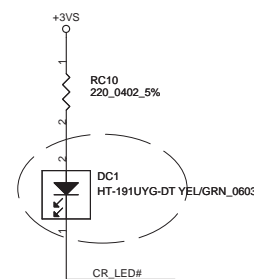
<http://hobi-elektronika.net>



48Mhz

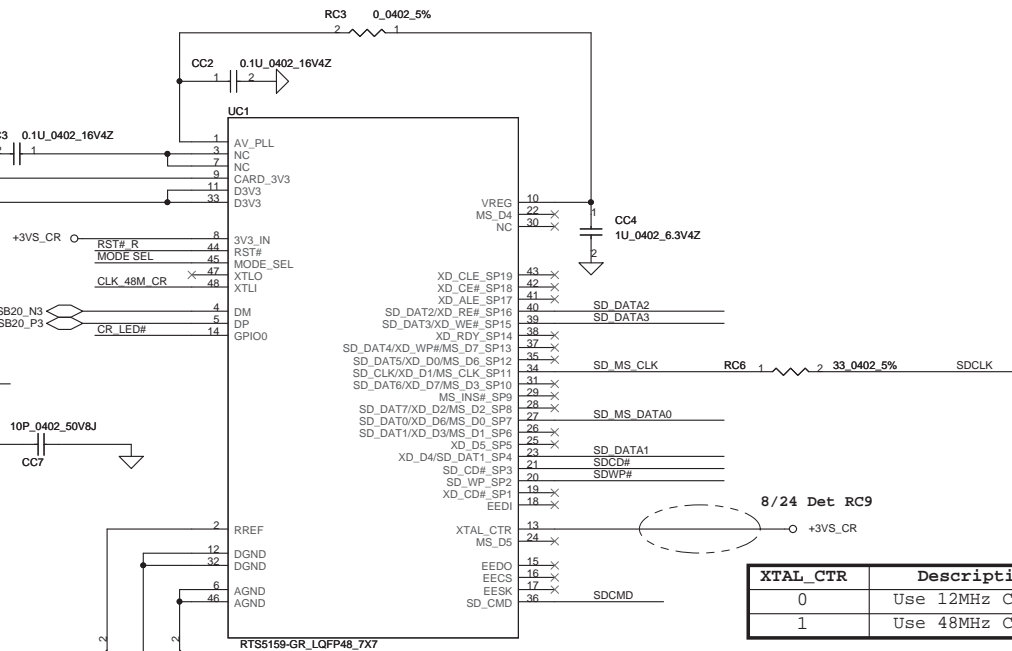
<8> CLK_48M_CR

CLK_48M_CR

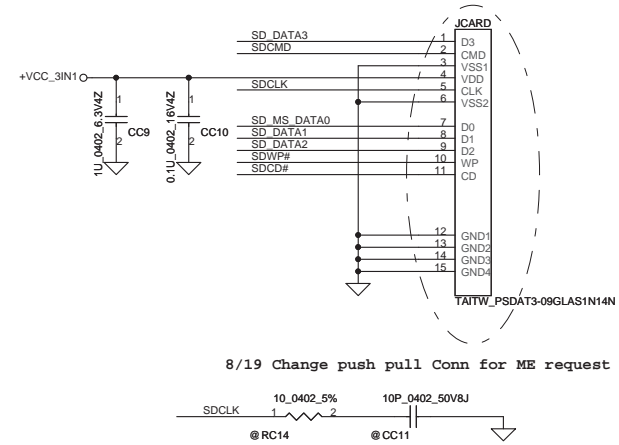


7/23 Change to TOP view LED

R	C	USB AUTO DE-LINK	MS FORMATTER	Description
0	NC	YES		Recommended
NC	47P	YES	YES	
NC	NC			Compatible with RTS5158E
NC	680P	YES		LED ON
10K	180P			LED ON
10K	680P		YES	

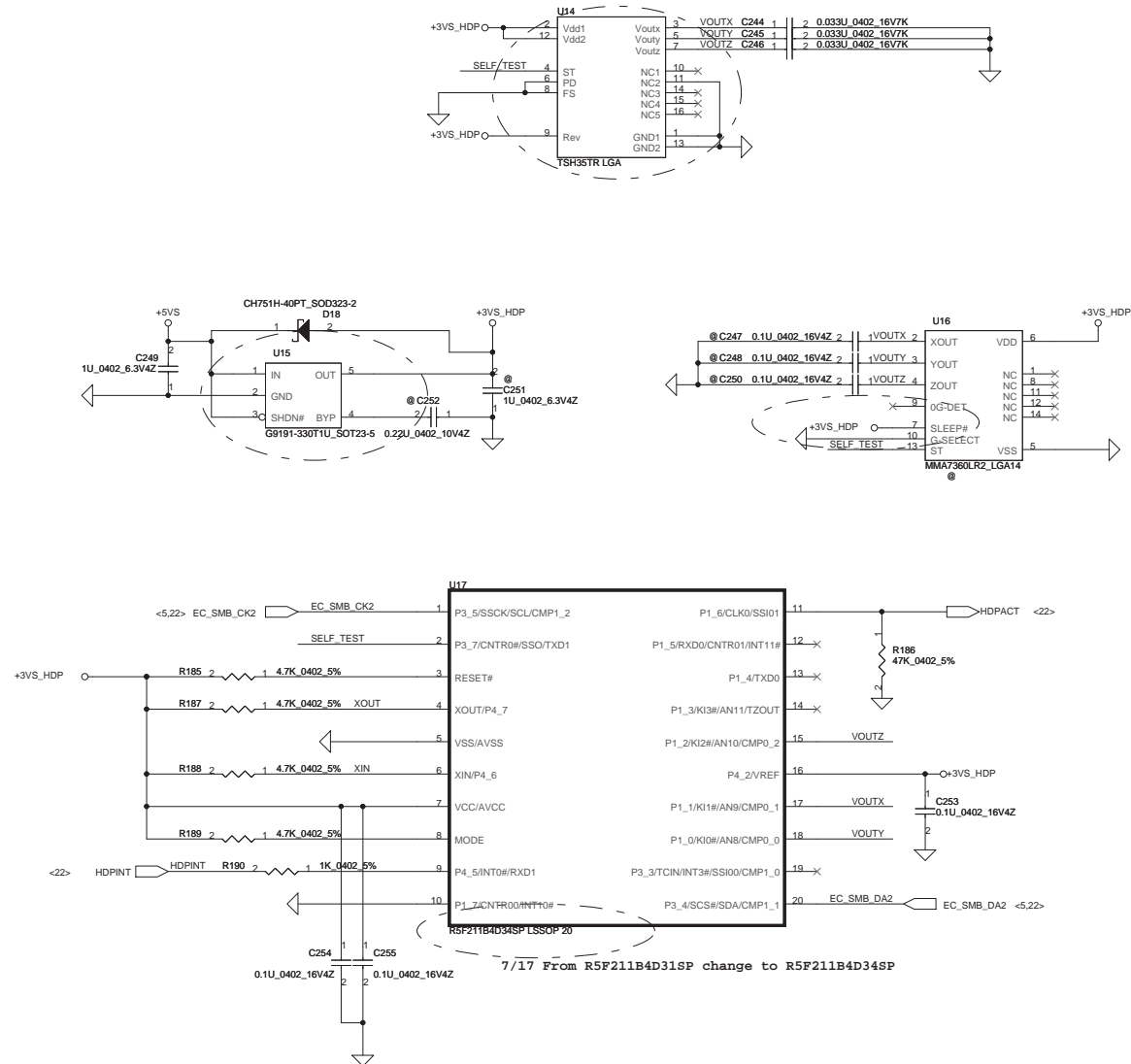


2 in 1 Card Reader



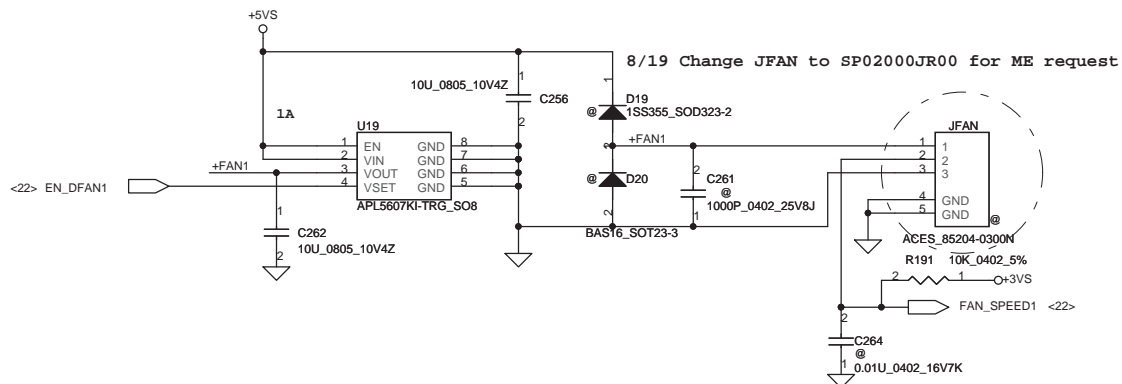
8/19 Change push pull Conn for ME request

G-Sensor

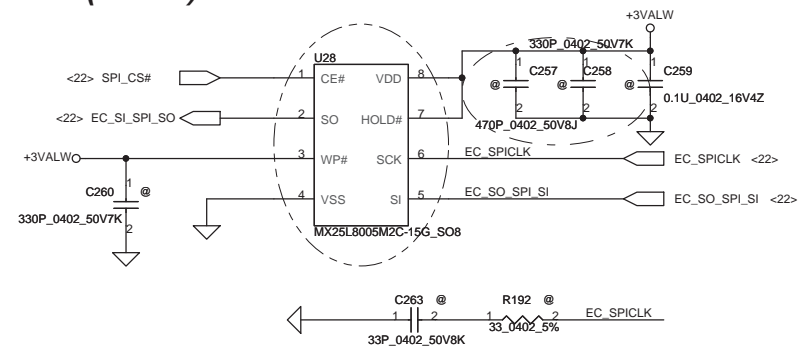


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FAN Control Circuit

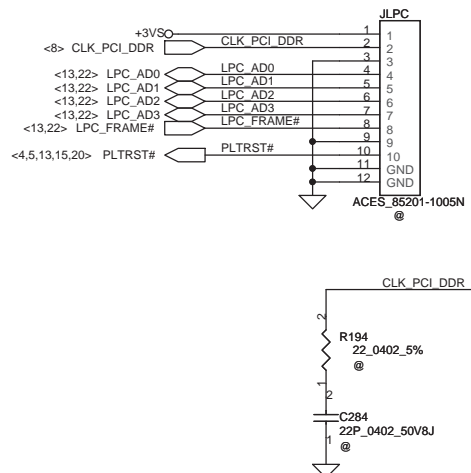


SPI Flash (8Mb*1)

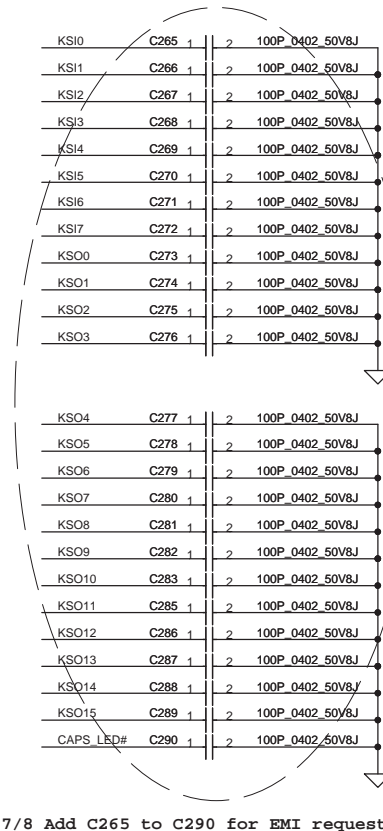
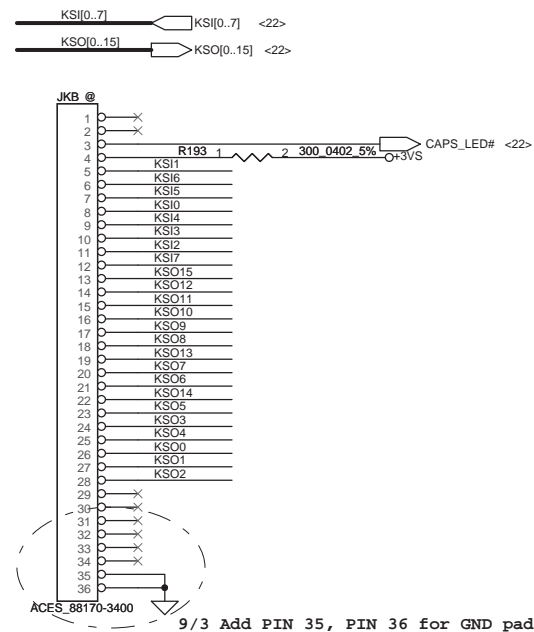


LPC Debug Port

Please place the connector neer to DDR door

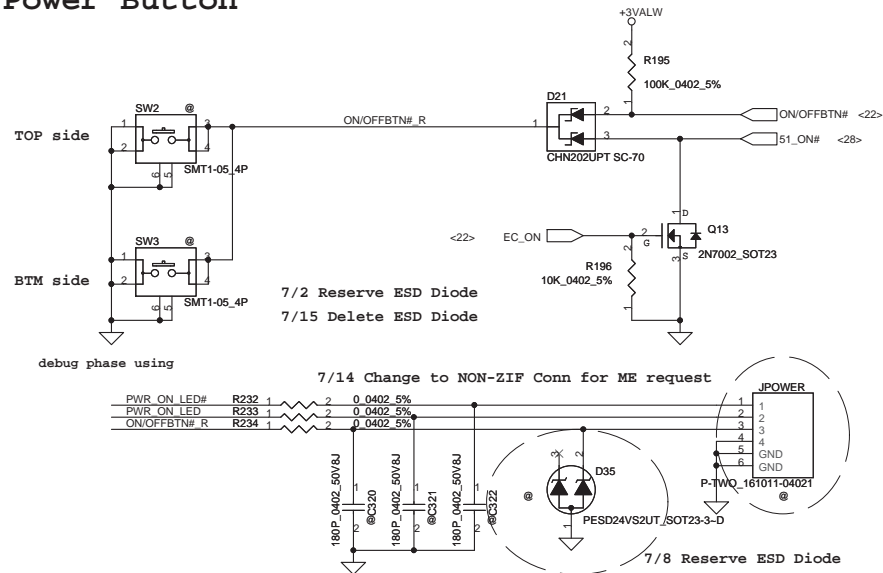


KEYBOARD CONN.



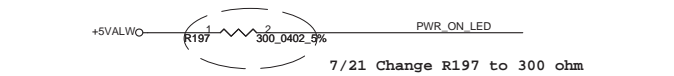
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Power Button

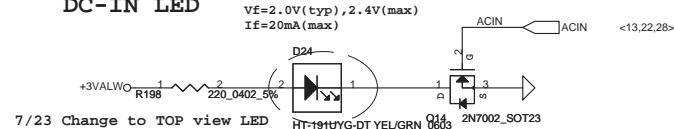


LED Conn

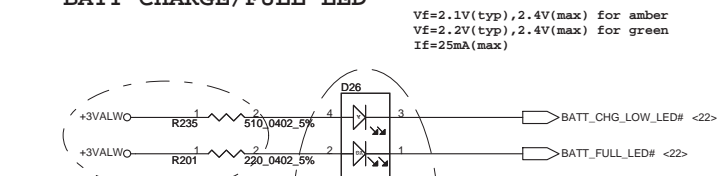
POWER LED



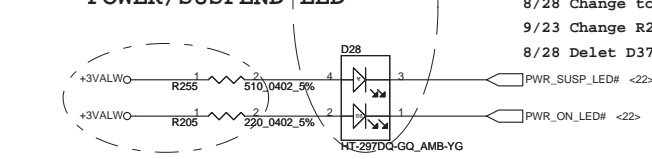
DC-IN LED



BATT CHARGE/FULL LED



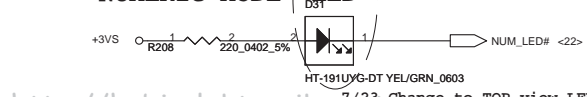
POWER/SUSPEND LED



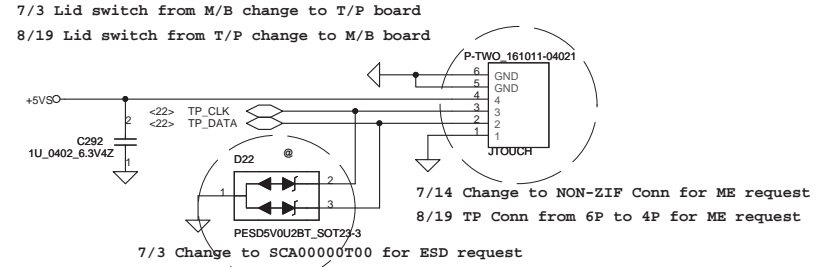
ARROW MODE LED



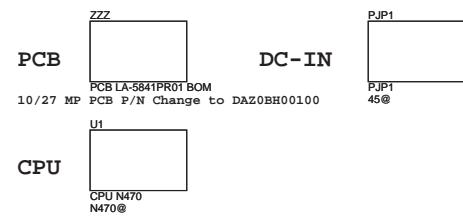
NUMERIC MODE LED



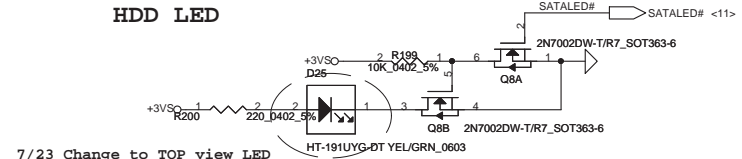
Touch/B Connector



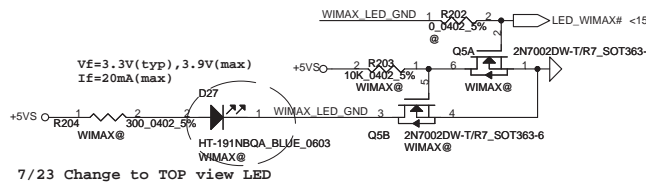
ISPD



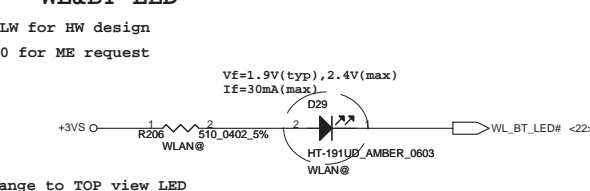
HDD LED



WiMAX&3G LED

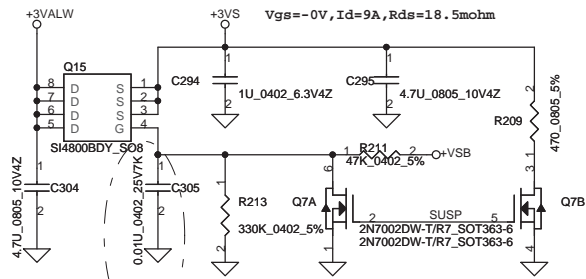


WL&BT LED

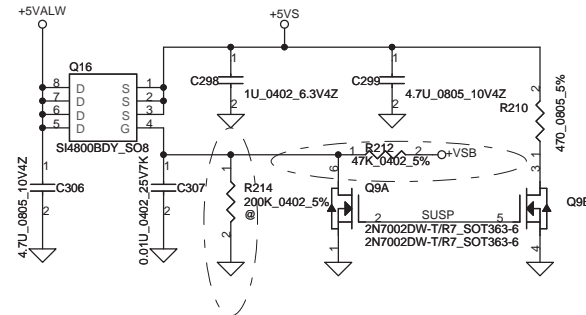


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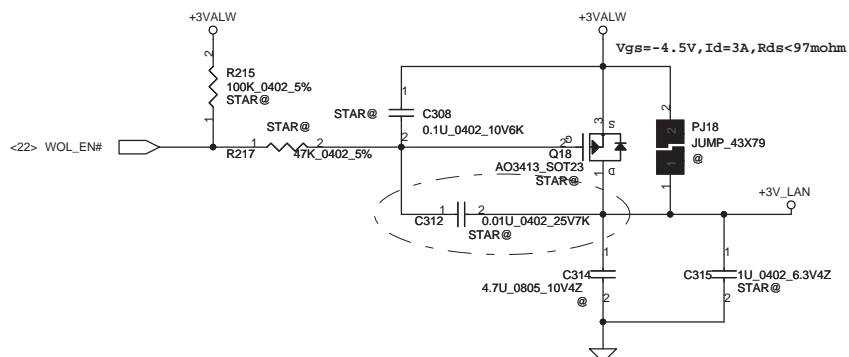
+3VALW TO +3VS



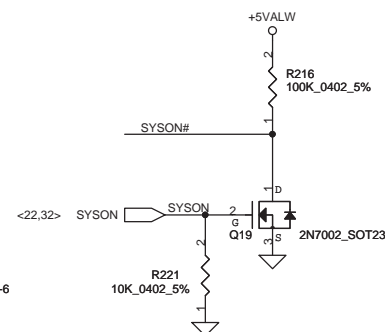
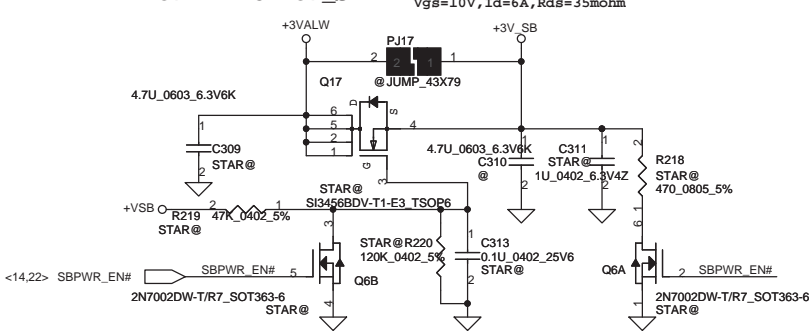
+5VALW TO +5VS



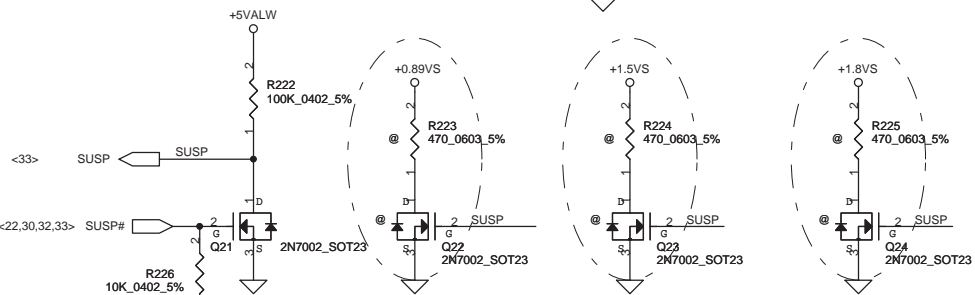
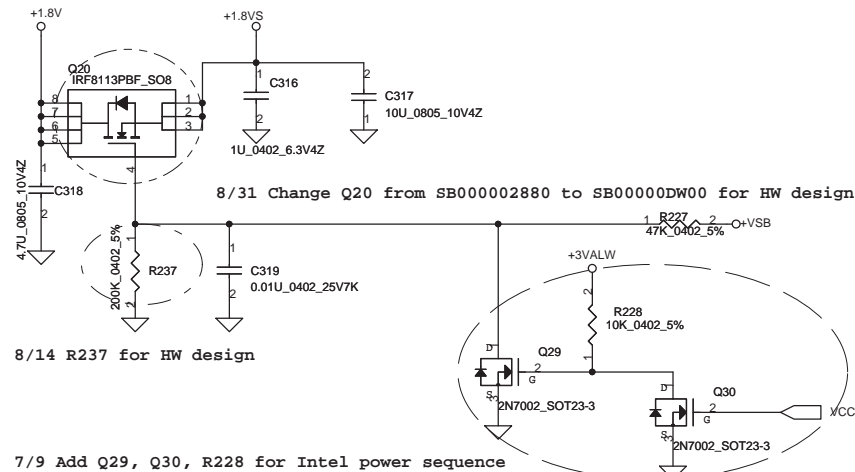
+3VALW TO +3V_LAN



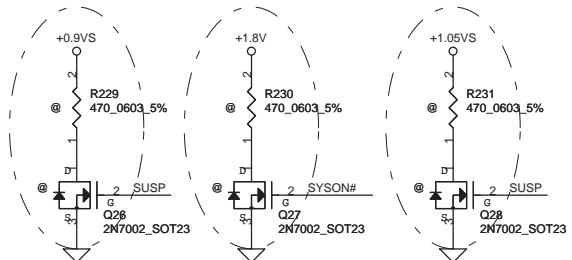
+3VALW TO +3V_SB



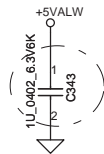
+1.8V TO +1.8VS



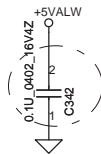
10/5 Reserve R223-R225, R229-R231 Q22-Q24, Q26-Q28 for HW cost down



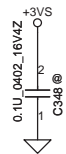
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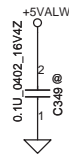
7/21 Placed closed H1



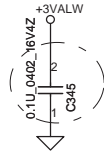
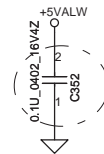
7/21 Placed closed H2



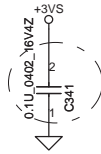
7/23 Placed closed R42



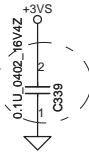
10/5 Placed closed H6



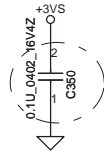
7/21 Placed closed H6



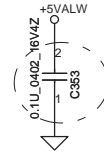
7/21 Placed closed H7



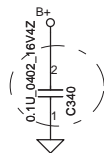
7/21 Placed closed H8



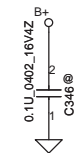
10/5 Placed closed Q2



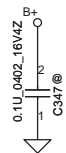
10/5 Placed closed H1



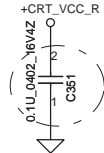
7/21 Placed closed H9



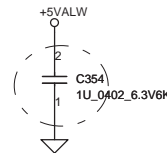
7/23 Placed closed PJ14



7/23 Placed closed PJ9



10/5 Placed closed H4



10/5 Placed closed H2

7/21 These cap for ESD request

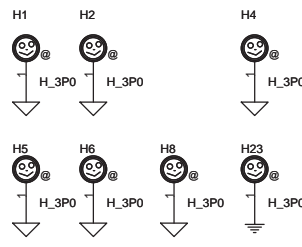
10/5 Add C339, C340-C342, C345, C350-C354 for ESD request

10/5 Change C343 to SE000000K80 for ESD request

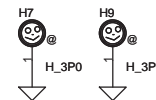
10/6 Change C354 to SE000000K80 for ESD request

Screw Hole

M/B

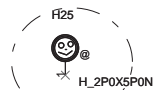
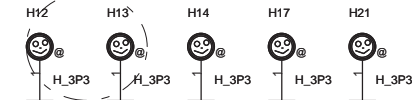


KB



9/23 Change H12, H13 to 3P3 for ME request

FAN

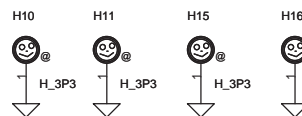


8/28 Add H25 with H_5P0X2P0N for ME request

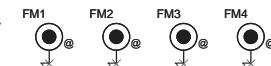


8/19 Add NON PTH hole H22 for Thermal module

MINI Card



FIDUCIAL_C40M80

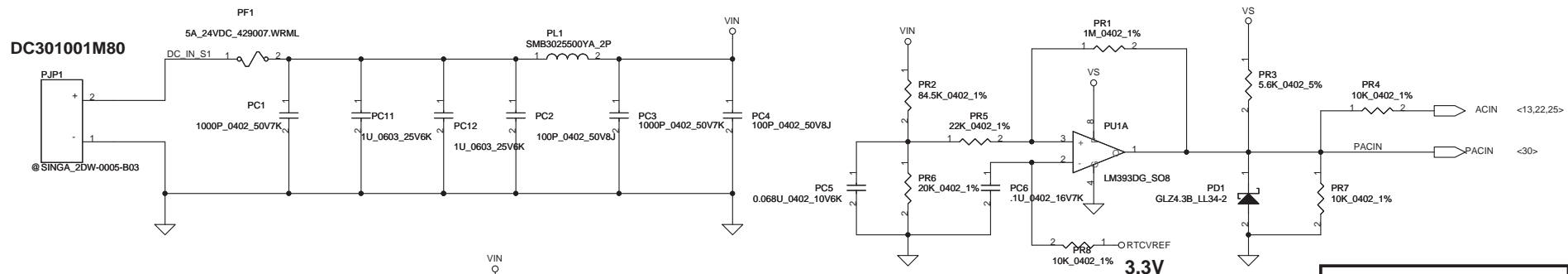


8/28 Add H24 with H_2P0X5P5N for ME request

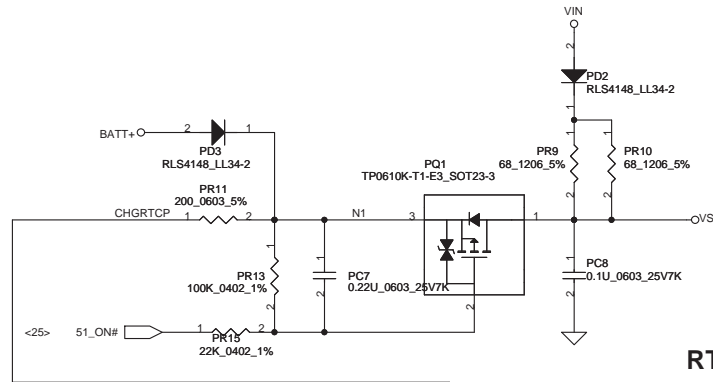
9/2 Det H24 with H_2P0X5P5N for ME request

9/29 Det H19 with H_2P0X5P5N for ME request

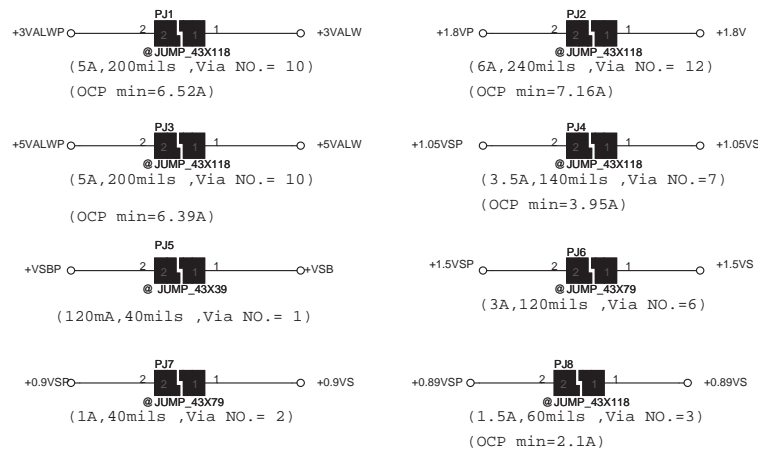
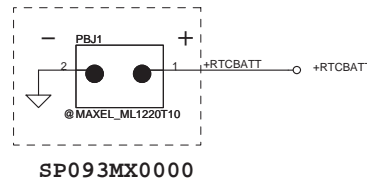
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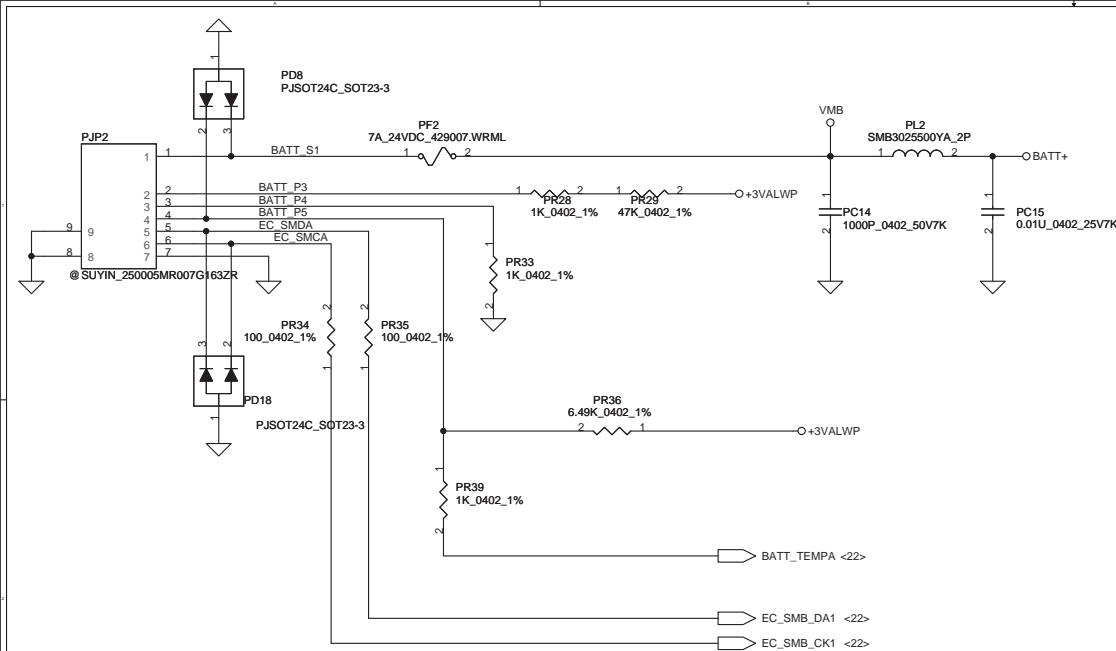
Vin Detector			
High	18.384	17.901	17.430
Low	17.728	17.257	16.976



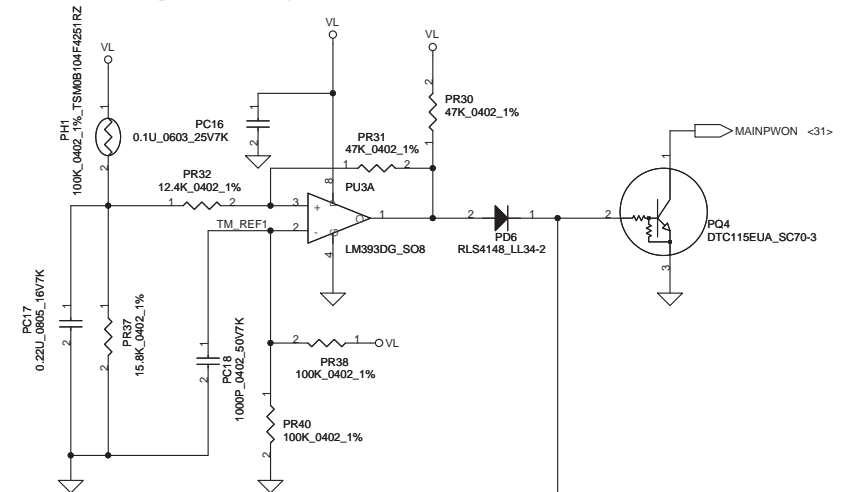
RTC Battery



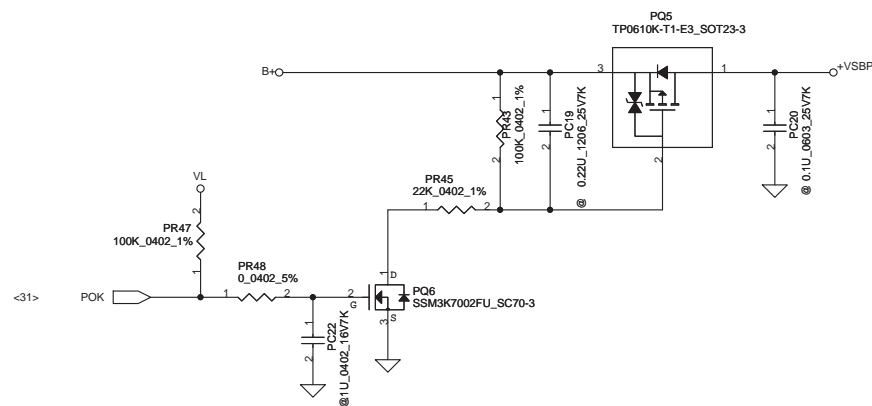
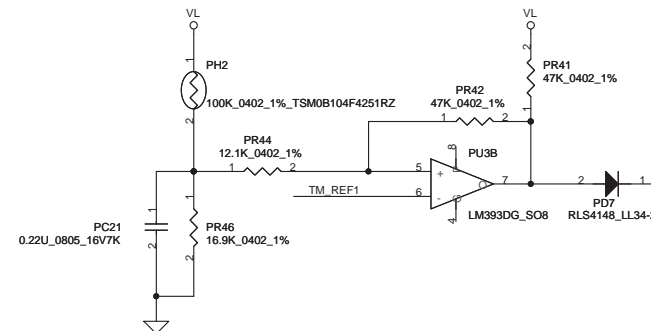
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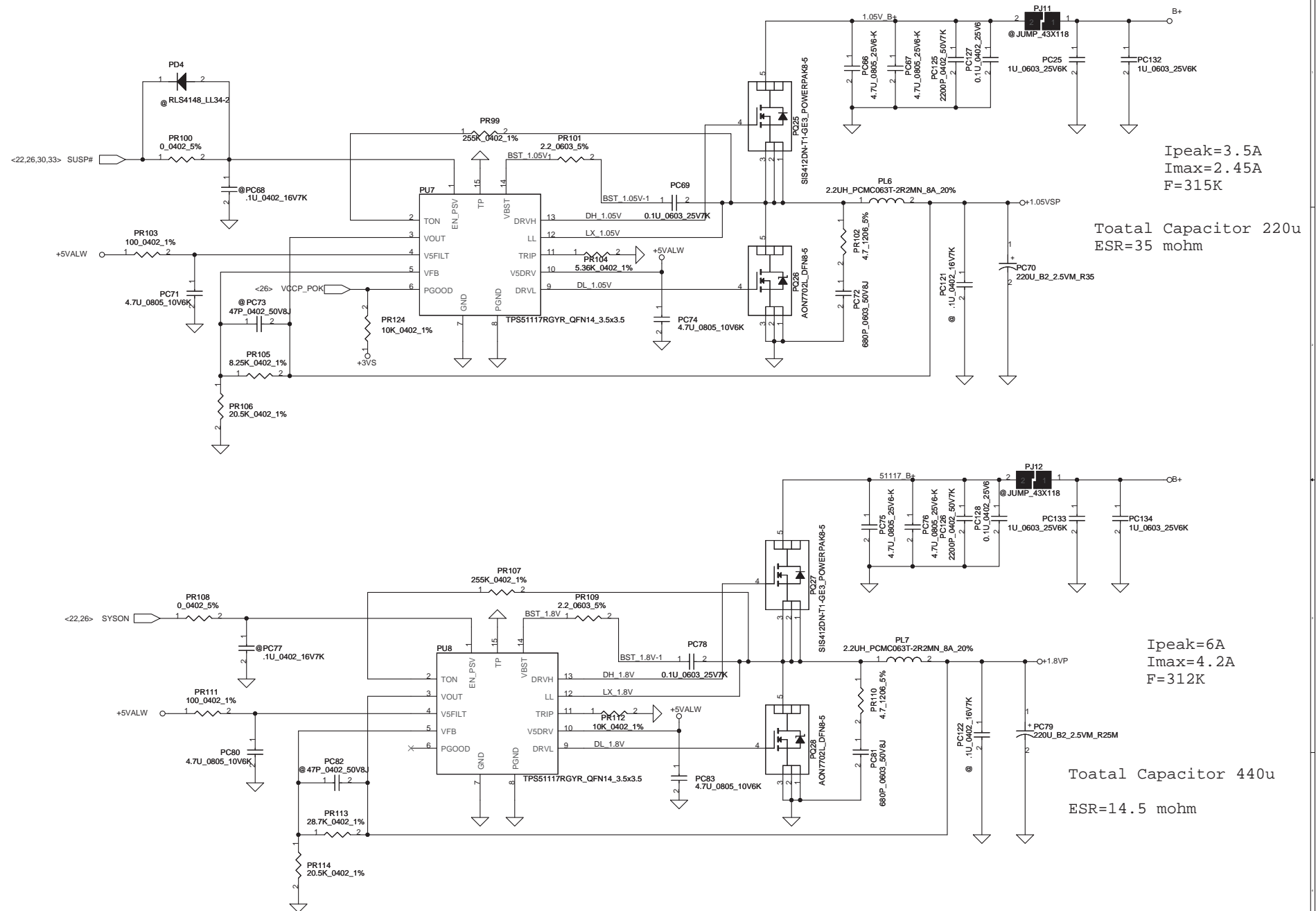
PH1 under CPU botten side :
CPU thermal protection at 92 degree C
Recovery at 56 degree C



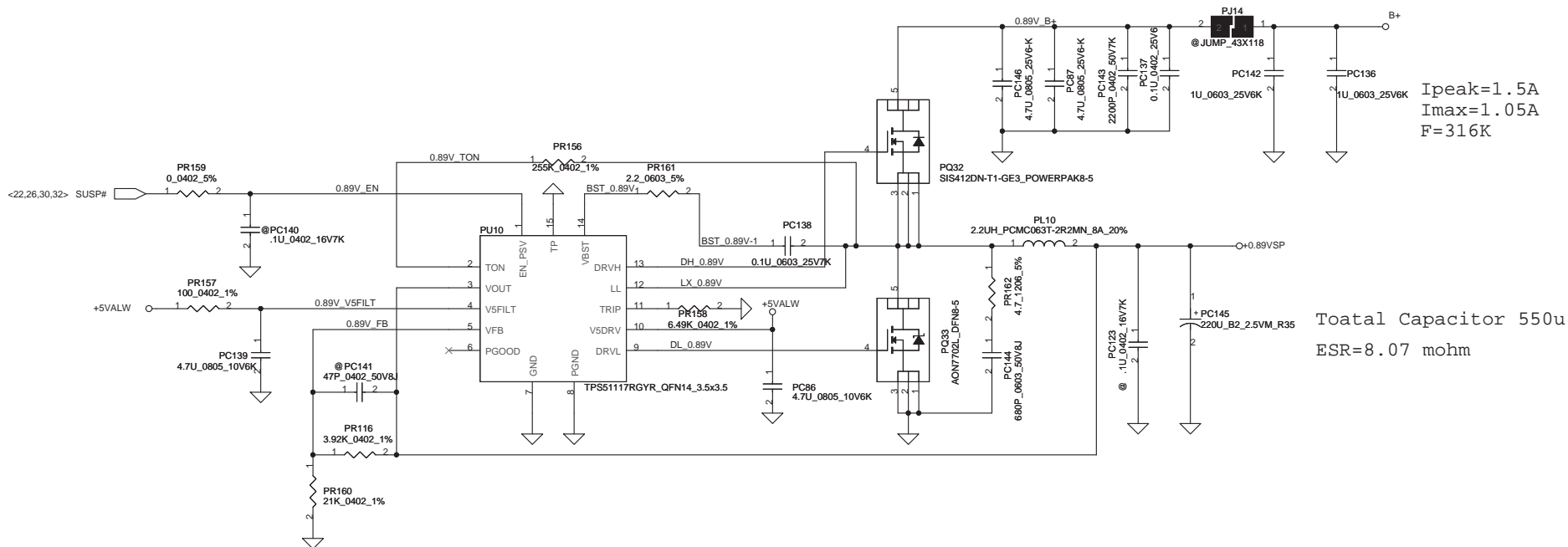
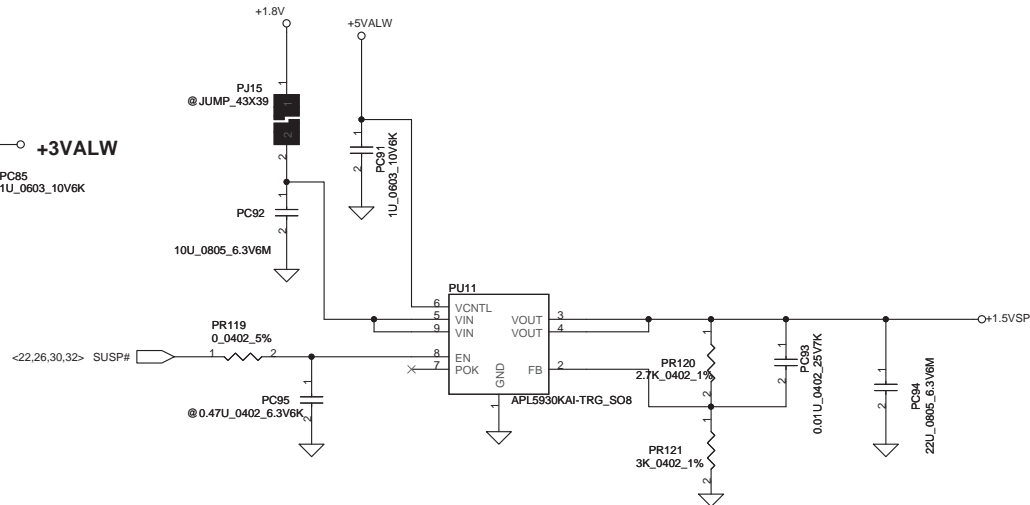
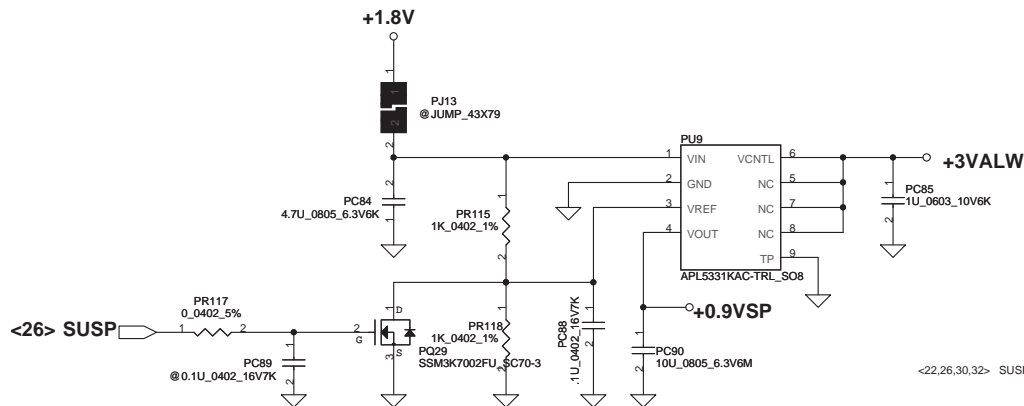
PH2 near main Battery CONN :
BAT. thermal protection at 92 degree C
Recovery at 53 degree C



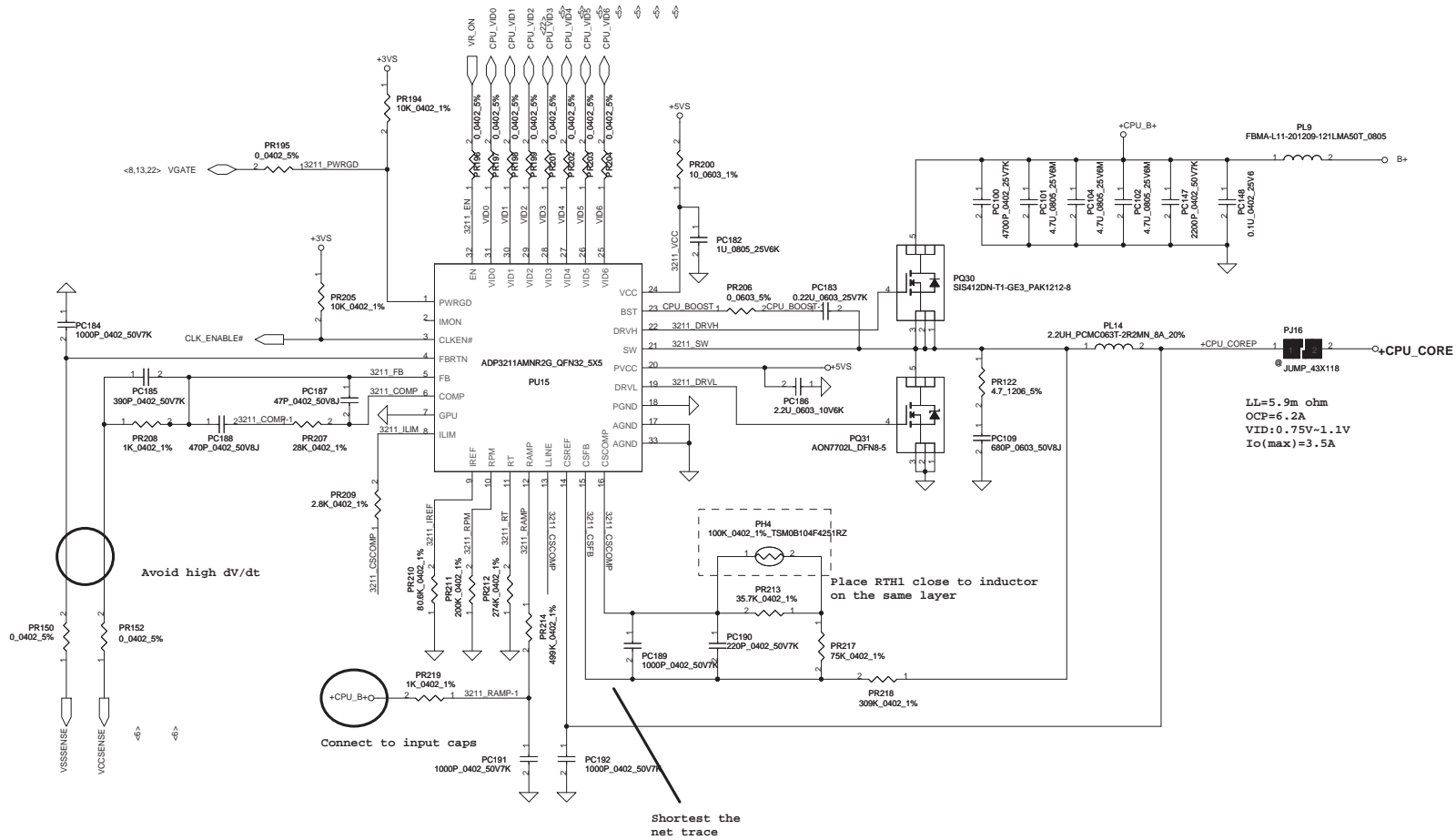
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NO	DATE	PAGE	MODIFICATION LIST		PURPOSE
EVT		P37-CPU_CORE	Change	PU15 SA00003DA0L --> SA00003DA00	Choice the A51 material
EVT		P35-1.05VSP/1.8VP	Change	PR124 422 ohm -->10K ohm	Deign change
DVT		P33-CHARGER	Delete	PD15	Deign change(Cause layout)
DVT		P35-1.05VSP/1.8VP	Change	PR104 13.7K-->5.36K	Deign change(OCP point)
DVT		P35-1.05VSP/1.8VP	Change	PR124 the same part number with PR4	Deign change(Use the same part number)
DVT		P32-Battery conn/otp	Reserve	the ESD diode	Deign change
PVT		P37-CPU_CORE	Change	PR209 1.8K-->2.8K	Change the OCP 6A-->9A
PVT		P34-+5VALWP/+3VALWP	Reserve	the sunnber PR82&PR81&PC58&PC59	EMI approvel
PVT		P28-DCIN&DECTOR	Change	PC7 1206-->0603	For cost down
PVT		P32-Battery conn/otp	Add	the ESD diode	EMI require
PVT		P28-DCIN&DECTOR	Change	DC-IN jack DC301009G00	Design change
pre-mp		P29-Battery conn / OTP	Change	PR32 -->12.4K , PR37-->15.8k,PR44-->12.1k,PR46-->16.9K	Thermal commond
pre-mp		P33-0.9VSP/1.5VSP/0.89VP	Change	PR158 2.49K-->6.49K	Design change

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PIR (Product Improve Record)

KAVAA LA-5841P SCHEMATIC CHANGE LIST
REVISION CHANGE: 0.1

	DATE	PAGE	MODIFICATION LIST	PURPOSE	
Item	Date	Page	Component	Solution	Request
1)	7/2	9	Reserve	R87 with 0 ohm	For support DPST function
2)	7/2	22	Add	R235 90 ohm bead and C323 with 6P	For EMI request
3)	7/2	13	Reserve	C207 with 22P	For EMI request
4)	7/2	18	Reserve	CA33 with 22P and RA31 with 22 ohm	For EMI request
5)	7/2	16	Change	Change L4 to SM070001310	For EMI request
6)	7/2	18	Reserve	CA34 with 0.01U to GND and RA32 with 4.7K ohm up +3VS	For ESD request
7)	7/2	25	Reserve	D32 with SCA00000R00	For ESD request
8)	7/3	25	Change	Lid switch from M/B change to T/P board	For design change
9)	7/3	19	Change	Change DA3,DA4,D22 to SCA00000T00	For ESD request
10)	7/3	4	Reserve	D33,D34 with SC300000000	For ESD request
11)	7/3	16	Reserve	D23 with SC300000000 from Sub board to M/B	For ESD request
12)	7/6	22	Change	Change R235 to L6 with SM010009E00	For EMI request
13)	7/8	24	ADD	Add C265-C290 with SE071101J80	For EMI request
14)	7/8	16	Swap	Pin swap for AGND	For layout
15)	7/8	18	Reserve	R235 withSD028000080	For EMI request
16)	7/8	27	Modify	Modify screw hole location	
17)	7/8	25	Reserve	D32 with SCA00000R00	For ESD request
18)	7/8	16	Reserve	D36 with SC300000000 from Sub board to M/B	For ESD request
19)	7/8	07	Add	C216,C217,C238,C291 with SE070104Z80	For EMI request
20)	7/9	26	Add	D29, D30 with SB570020020 and R228 with SD028100280	For power sequence
21)	7/9	13	Add	C293 with SE070104Z80	
22)	7/9	25	Change	R232, R233, R234 with SD028000080	Need to EMI confirm on EVT
23)	7/9	18,19	Modify	modify 2 SPK solution	For TOSHIBA request
24)	7/10	20	Change	UL1 with SA00002XC10	For low power solution
25)	7/10	16	Change	JUSBC1 to DC233004Q00	For ME suggest
26)	7/10	16	Swap	USB20_P0_R USB20_N0_R, USB20_P0_R_S, USB20_N0_R_S	For layout request
27)	7/10	10	Add	J2	For cost down PolySwitch
28)	7/13	8	Add	C296, C297 with SE071220J80	For RF request
29)	7/13	8	Add	C300, C301 with SE068330K80	For RF request
30)	7/13	8	Add	C302, C303, C324 with SE068330K80	For RF request
31)	7/13	8	Add	C325, C326, C327 with SE068330K80	For RF request
32)	7/13	8	Change	R53, R54, R57 to SM01000B200	For RF request
33)	7/13	8	Add	C328, C329, C330 with SE071470J80	For RF request
34)	7/13	19	Reserve	CA25 with SE070104Z80	For RF request
35)	7/14	21	Delete	YC1, CC12, CC13	For cost down
36)	7/14	25	Change	JTOUCH1 to NON-ZIF	For ME suggest
37)	7/14	25	Change	JPOWER1 to NON-ZIF	For ME suggest
38)	7/15	22	Change	INVT_PWM from PIN 21 change to PIN 25	For EC suggest
39)	7/15	22	Change	USB_CHG_EN# from PIN 68 change to PIN 29	For EC suggest
40)	7/15	5	Change	SB to CPU signal to CPU side	For placement
41)	7/15	16	Swap	USB20_N3 and USB20_P4 location	For layout request
42)	7/15	25	Delete	D32	For ESD request
43)	7/16	17	Delete	BT and Camera BTO item	For BOM request
44)	7/16	19	Delete	MIC BTO item	For BOM request
45)	7/16	21	Change	For RC8 change to reserve	For realtek request
46)	7/16	23	Delete	G-senser BTO item	For BOM request
47)	7/16	16	modify	USB_OC#0 dis-connect to +USB_VCCB	For schematic error
48)	7/16	26	modify	Change Q22 pull up from 0.89V to 0.89VS	For schematic error
49)	7/16	9	Reserve	C331 and C332 with SE071100J80	For EMI request
50)	7/16	9	Reserve	C333 and C334 with SE071100J80	For EMI request
51)	7/17	23	Change	U17 from R5F211B4D31SP change to R5F211B4D34SP	For TOSHIBA request
52)	7/17	12	Change	Reassign Tiger point USB port	For TOSHIBA concern
53)	7/17	21	Delete	RC13	For cost down
54)	7/17	20	Change	JLAN from SANTA_130452-3_13P-T to Santa_130452-8_8P-T	For not support LAN LED fu
55)	7/17	20	Delete	RL7, RL8, RL9, RL11, CL16, CL21	For not support LAN LED fu
56)	7/17	15	Change	R156, R157 for JWLAN1 change to JGPS1	For debug
57)	7/20	4	Add	R238, R239 with SD028100280	For Ref board design
58)	7/20	5	Add	C335 with SE000000K80	For Ref board design
59)	7/20	5	Reserve	C336 with SE074221K80	For Ref board design
60)	7/20	13	Delete	EC_THERM# pull up	Follow NIM10
61)	7/20	13	Add	T43, T44	Follow NIM10
62)	7/20	13	Add	SLPIOVR pull up 8.2k to +3vs	Follow NIM10
63)	7/21	3	Swap	XDP_TRST#, XDP_TDO, XDP_TDI, XDP_TCK, XDP_TMS	For layout request
64)	7/21	7	Reserve	C60 with SE107225K80	

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REVISION CHANGE: 0.1-->0.2

NO	DATE	PAGE	MODIFICATION LIST	PURPOSE
65)	7/21	8	Reserve	C303,C324,C325,C326,C327,C296,C297,C300,C301
66)	7/21	8	Change	WVAN_CLKREQ# from REQ4 to REQ11 For silego suggest
67)	7/21	9	Change	C331 to Shunt Capacitor For EMI request
68)	7/21	15	Change	C334 to Shunt Capacitor For EMI request
69)	7/21	17	Swap	USB20_N7, USB20_P7 For layout request
70)	7/21	19	Add	RA33, RA34 with SD028820180 For AMP gain
71)	7/21	25	Change	R197 to 300ohm For common design
72)	7/21	4	Add	R137 to GND For Intel request
73)	7/21	13	Add	R240 pull up to +RTCBATT For Intel request
74)	7/21	13	Change	C156 with SE000000K80 For Intel request
75)	7/21	27	Add	C339-C345 with SE070104Z80 For ESD request
76)	7/22	8	Add	R241 pull up to +3VS For Intel request
77)	7/22	19	Add	RA33-RA40, CA35-CA38 For AMP gain
78)	7/22	8	Delete	R64, R66 For Intel suggest CLK schematic
79)	7/22	8	Add	R242-R253 For Intel suggest CLK schematic
80)	7/23	20	Change	JLAN from Santa_130452-8 8P-T to SANTA_130452-6 For ME request
81)	7/23	21	Change	JCARD with TAITW_PSDAT3-09GLAS1N14N For TOSHIBA request
82)	7/23	21	Change	DC1 for TOP view LED For ME request
83)	7/23	25	Change	D24-D31 for TOP view LED For ME request
84)	7/23	27	Reserve	C346-C348 with SE070104Z80 For ESD request
85)	7/27	4	Change	C302 to GND for +1.8V pull up For schematic error
86)	7/27	16	Swap	USB20_P4_R_S and USB20_N4_R_S For schematic error
87)	8/14	4	Add	DDR_VREF net name For layout request
88)	8/14	5	Add	CRT_IRTN net name For layout request
88)	8/14	5	Add	DAC_IREF net name For layout request
89)	8/14	5	Change	Net name from H_GTLREF to +H_GTLREF For layout request
90)	8/14	5	Change	Net name from H_EXTBGREF to +H_EXTBGREF For layout request
91)	8/14	8	Add	R250 pull up with SD028470080 For Intel request
92)	8/14	13	Add	R254 pull down with SD028100380 For EC request
93)	8/14	17	Swap	USB20_N7, USB20_P7 For layout request
94)	8/14	18	Add	R235 with SD028000080
95)	8/14	18	Add	Net name to HP_L_R and HP_R_R For layout request
96)	8/14	18	Add	Net name to CPVEE For layout request
97)	8/14	26	Add	R237 with SD028200380 For HW design
98)	8/14	9	Add	R87 with SD028000080 For not support DPST
99)	8/14	9	Det	R88 with SD028000080 For not support DPST
100)	8/14	24	Change	U28 from SA00000XT00 to SA00002T000 For BIOS ROM size
101)	8/19	25	Det	Lid switch from T/P change to M/B board For ME request
102)	8/19	17	Add	U22, C332, C333 for Lid function For ME request
103)	8/19	21	Change	JCARD for push pull Conn For ME request
104)	8/19	24	Change	JFAN to SP02000JR00 For ME request
105)	8/19	16	Change	JUSBC to DC233004W00 For ME request
106)	8/19	25	Change	JTOUCH to SP01000WX00 For ME request
107)	8/19	27	Add	H22 NON PTH hole For Thermal module
108)	8/21	16	Add	USB_CHG_EN# has to be connected to OE# pin For SPEC REV 0.5
109)	8/24	4	Change	+DDR_VREF to DDR_VREF For HW schematic review
110)	8/24	5	Det	CRT_IRTN net name For HW schematic review
111)	8/24	5	Change	+H_GTLREF to H_GTLREF For HW schematic review
112)	8/24	5	Change	+H_EXTBGREF to H_EXTBGREF For HW schematic review
113)	8/24	16	Change	U12 to SA00002XX00 For HW schematic review
114)	8/24	8	Change	Net name to FSB for U3.2
115)	8/24	10	Change	D1, D2, D3 For ESD request
116)	8/24	17	Change	JSATA to ALLTO_C16674-12204-L For ME request
117)	8/24	18	Change	R235 to RA21
118)	8/24	20	Change	JLAN for Deep connector For ME request
119)	8/24	20	Add	Connect ISOLATEB to EC
120)	8/24	21	Det	RC9
121)	8/23	27	Reserve	C343, C342, C345, C341, C339, C340
122)	8/27	8	Det	C93, C94, C95, C102 For low power CLK GEN
123)	8/27	8	Add	C303, C324, C325, C326, C327 to GND For RF request
124)	8/27	8	Det	296, C297 For RF request
125)	8/28	27	Add	H24 with H_2P0X5P5N For ME request
126)	8/28	25	Change	SC5191UD000 and SC591UYG000 For HW design
127)	8/31	27	Add	H25 with H_5P0X2P0N For ME request
128)	8/31	26	Change	Q20 from SB000002880 to SB00000DW00 For HW design
129)	9/1	13	Change	R125 to SM010027780 For EMI request
130)	9/1	13	Add	C207 to SE071100J80 For EMI request
131)	9/2	27	Det	H24 with H_2P0X5P5N For ME request
132)	9/3	16	Add	PIN 21, PIN 22 on JUSB For layout request
132)	9/3	16	Add	PIN 3, PIN 4 on JSPKR, JSPKL For layout request
132)	9/3	16	Add	PIN 35, PIN 36 on JKB For layout request
133)	9/4	7	Reserve	C66, C67, C68, C69, C72, C75, C77, C78, C79, C81, C83, C84, C85

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PIR (Product Improve Record)

NPVAA LA-5841P SCHEMATIC CHANGE LIST
REVISION CHANGE: 0.2-->0.3

NO	DATE	PAGE	MODIFICATION LIST	PURPOSE
134)	9/23	13	Change	RP17 to R256, R257, R258
135)	9/23	27	Change	H12, H13 to 3P3
136)	9/23	25	Change	R235, R255 to SD028220080 and +5VALW to +3VALW
137)	9/28	16	Det	D36 with SC300000000
138)	9/28	10	Reserve	Reserve F1 for cost down PolySwitch
140)	10/5	27	Add	C339, C340-C342, C345, C350-C354 with SE070104Z80
141)	10/5	27	Change	C343 to SE000000K80
142)	10/5	18	Add	RA7 and RA11 with SD013000080
143)	10/5	26	Reserve	R223-R225, R229-R231 Q22-Q24, Q26-Q28 for HW cost down
144)	10/6	25	Change/Det	Delet D37, D38 and Change D26 and D28 to SC500001900
145)	10/6	15	Change	R156, R157 for JWLAN change to JGPS
146)	10/6	27	Change	C354 to SE000000K80

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NPVAA LA-5841P SCHEMATIC CHANGE LIST
REVISION CHANGE: 0.3-->1.0

NO	DATE	PAGE	MODIFICATION	LIST	PURPOSE
147)	10/19	4	Change	footprint T5, T6 and T7 from TPC24 to TPC12	For layout request
148)	10/20	16,17	Det	L4, and L5	For EMI request
149)	10/27	19	Det	DA4 and DA5	For ESD request
150)	11/12	24	Change	U28 from SA000002T00 to SA0000XT000	For BIOS ROM size

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